AURIX™ TC2xx Data Sheet Addendum

About this document

Scope and purpose

This is an addendum to the TC2xx Data Sheet listing all intended product variants, key parameters such as memory size, and optional features.

Prefix naming conventions

- SAK: $T_{ambient}$ Temperature Range from -40 °C up to +125 °C
- SAL: $T_{ambient}$ Temperature Range from -40 °C up to +150 °C (packaged device)

Feature package naming conventions

- T – Standard type without HSM
- TP – Standard type with HSM enabled
- TA – ADAS feature package – HSM enabled
- TX – Truck / SRAM extension – HSM enabled

Table of contents

1 TC21x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 0 TC16E		ADC CHAN.	FlexRay (#/ch.)	ETH	HSM	LOCK-STEP	CAN FD	CAN FD
									DSPR (KB)	PSPR (KB)							ISO 11898-1
SAK-TC214L-8F133N AC	STANDARD	PG-TQFP-144-27	-40°C - +125 °C	0146 1142 H	133	0.5	64@125k	56	48	8	24	No	No	No	Yes	Yes	Yes
SAK-TC213L-8F133N AC	STANDARD	PG-TQFP-100-23	-40°C - +125 °C	0146 1042 H	133	0.5	64@125k	56	48	8	24	No	No	No	Yes	Yes	Yes
SAK-TC213L-8F133F AC	STANDARD	PG-TQFP-100-23	-40°C - +125 °C	0146 1042 H	133	0.5	64@125k	56	48	8	24	No	No	No	Yes	Yes	No
SAK-TC212L-8F133F AC	STANDARD	PG-TQFP-80-7	-40°C - +125 °C	0146 1242 H	133	0.5	64@125k	56	48	8	14	No	No	No	Yes	Yes	No
SAK-TC212L-8F133N AC	STANDARD	PG-TQFP-80-7	-40°C - +125 °C	0146 1242 H	133	0.5	64@125k	56	48	8	14	No	No	No	Yes	Yes	Yes

2 TC22x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 0 TC16E		ADC Chan.	FlexRay (#/ch.)	ETH	HSM	LOCK STEP	CAN FD	CAN FD
									DSPR (KB)	PSPR (KB)							ISO 11898-1
SAK-TC224L-16F133N AC	STANDARD	PG-TQFP-144-27	-40°C - +125 °C	0246 2142 H	133	1	96@ 125k	96	88	8	24	No	No	No	Yes	Yes	Yes
SAK-TC223L-16F133N AC	STANDARD	PG-TQFP-100-23	-40°C - +125 °C	0246 2042 H	133	1	96@125k	96	88	8	24	No	No	No	Yes	Yes	Yes
SAK-TC222L-16F133N AC	STANDARD	PG-TQFP-80-7	-40°C - +125 °C	0246 2242 H	133	1	96@125k	96	88	8	14	No	No	No	Yes	Yes	Yes

3 TC23x

3.1 Standard variants TC23x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 0 TC16E		ADC Chan.	FlexRay (#/ch.)	ETH	HSM	CAN FD
									DSPR (KB)	PSPR (KB)					ISO 11898-1
SAK-TC237LP-32F200N AC	STANDARD	PG-LFBGA-292-6	-40°C - +125 °C	4446 3242 H	200	2	128@125k	192	184	8	24	1 / 2	No	Yes	Yes
SAK-TC234LP-32F200N AC	STANDARD	PG-TQFP-144-27	-40°C - +125 °C	4446 3142 H	200	2	128@125k	192	184	8	24	1 / 2	No	Yes	Yes
SAK-TC233LP-32F200N AC	STANDARD	PG-TQFP-100-23	-40°C - +125 °C	4446 3042 H	200	2	128@125k	192	184	8	24	1 / 2	No	Yes	Yes

3.2 ADAS type TC23x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 0 TC16E		LMU (KB)	EMEM (KB)	ADC Chan.	FlexRay (#/ch.)	ETH	HSM	FFT
									DSPR (KB)	PSPR (KB)							
SAK-TC234LA-32F200F AB	STANDARD	PG-TQFP-144-27	-40°C - +125 °C	4443 3941 H 4447 3941 H	200	2	128@125k	736	184	8	32	512	24	1 / 2	Yes	Yes	Yes

3.3 Extended type TC23x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 0 TC16E		LMU (KB)	EMEM (KB)	ADC Chan.	FlexRay (#/ch.)	ETH	HSM	FFT
									DSPR (KB)	PSPR (KB)							
SAK-TC234LX-32F200F AB	STANDARD	PG-TQFP-144-27	-40°C - +125 °C	4443 3941 H 4447 3941 H	200	2	128@125k	736	184	8	32	512	24	1 / 2	Yes	Yes	No

4 TC26x

4.1 Standard variants TC26x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 TC16P		CORE 0 TC16E		LMU (KB)	ADC CHAN.	ETH	CAN FD	CAN FD ISO frame
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)					
SAK-TC267D-40F200N BC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	0546 6652$_H$	200	2.5	16 @500k	240	120	32	72	16	0	50	Yes	Yes	Yes
SAK-TC267D-40F200S BC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	0544 6651$_H$	200	2.5	16 @500k	240	120	32	72	16	0	50	Yes	Yes	No
SAK-TC265D-40F200N BC	STANDARD	PG-LQFP-176-22	-40°C – +125°C	0546 6152$_H$	200	2.5	16 @500k	240	120	32	72	16	0	50	Yes	Yes	Yes
SAK-TC264D-40F200N BC	STANDARD	PG-LQFP-144-22	-40°C – +125°C	0546 6052$_H$	200	2.5	16 @500k	240	120	32	72	16	0	40	Yes	Yes	Yes
SAL-TC267D-40F200N BC	STANDARD	PG-LFBGA-292-6	-40°C – +150°C	0546 6652$_H$	200	2.5	16 @500k	240	120	32	72	16	0	50	Yes	Yes	Yes

4.2 ADAS type TC26x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 TC16P		CORE 0 TC16E		LMU (KB)	EMEM (KB)	ADC CHAN.	ETH	CIF	FFT	CAN FD	CAN FD ISO frame
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)								
SAK-TC264DA-40F200N BC	STANDARD	PG-LQFP-144-22	-40°C – +125°C	0547 6852$_H$	200	2.5	16 @500k	752	120	32	72	16	0	512	40	Yes	Yes	Yes	Yes	Yes

5 TC27x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 AND 2 TC16P		CORE 0 TC16E		LMU (KB)	ADC CHAN.	FlexRay (#/ch.)	ETH	HSM	CAN FD	CAN FD ISO frame
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)							
SAK-TC277TP-64F200N DC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	4746 7172$_H$	200	4	64 @ 500k	472	120	32	112	24	32	60	1 / 2	Yes	Yes	Yes	Yes
SAK-TC277TP-64F200S DC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	4746 7172$_H$	200	4	64 @ 500k	472	120	32	112	24	32	60	1 / 2	Yes	Yes	Yes	No
SAK-TC275TP-64F200N DC	STANDARD	PG-LQFP-176-22	-40°C – +125°C	4746 7072$_H$	200	4	64 @ 500k	472	120	32	112	24	32	48	1 / 2	Yes	Yes	Yes	Yes

6 TC29x

6.1 Standard variants TC29x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMPERATURE RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 AND 2 TC16P		CORE 0 TC16P		LMU (KB)	ADC CHAN.	FlexRay (#/ch.)	ETH	HSM	CAN FD	CAN FD ISO frame
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)							
SAL-TC299TP-128F300N BC	STANDARD	PG-LFBGA-516-5	-40°C – +150°C	4B46 9252$_H$	300	8	128@500k	728	240	32	120	32	32	84	2 / 4	Yes	Yes	Yes	Yes
SAL-TC298TP-128F300N BC	STANDARD	PG-LBGA-416-26	-40°C – +150°C	4B46 9152$_H$	300	8	128@500k	728	240	32	120	32	32	60	2 / 4	Yes	Yes	Yes	Yes
SAK-TC297TP-128F300N BC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	4B46 9052$_H$	300	8	128@500k	728	240	32	120	32	32	60	2 / 4	Yes	Yes	Yes	Yes

6.2 Extended type TC29x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMP. RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 AND 2 TC16P		CORE 0 TC16P		LMU (KB)	EMEM (KB)	ADC CHAN.	FlexRay (#/ch.)	ETH	CIF	FFT	HSM	CAN FD	CAN FD ISO frame	AGBT
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)											
SAK-TC299TX-128F300N BC	STANDARD	PG-LFBGA-516-5	-40°C – +125°C	4B47 9A52$_H$	300	8	128 @500k	2776	240	32	120	32	32	2048	84	2 / 4	Yes	No	No	Yes	Yes	Yes	No
SAK-TC297TX-128F300N BC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	4B47 9852$_H$	300	8	128 @500k	2776	240	32	120	32	32	2048	60	2 / 4	Yes	No	No	Yes	Yes	Yes	No

6.3 ADAS Type TC29x

DERIVATIVE	PRODUCTION STATUS	PACKAGE TYPE	TEMP. RANGE	CHIP ID	FREQ. (MHz)	FLASH (MB)	EEPROM (KB)	TOTAL SRAM (KB)	CORE 1 AND 2 TC16P		CORE 0 TC16P		LMU (KB)	EMEM (KB)	ADC Chan	Flex Ray (#/ch.)	ETH	CIF	FFT	HSM	CAN FD	CAN FD ISO frame	AGBT
									DSPR (KB)	PSPR (KB)	DSPR (KB)	PSPR (KB)											
SAK-TC297TA-128F300N BC	STANDARD	PG-LFBGA-292-6	-40°C – +125°C	4B47 9052$_H$	300	8	128 @500k	2776	240	32	120	32	32	2048	60	2 / 4	Yes	Yes	Yes	Yes	Yes	Yes	No

7 Memory map of variants

This section shows the influence of the feature variants on the memory map.

7.1 TC21x

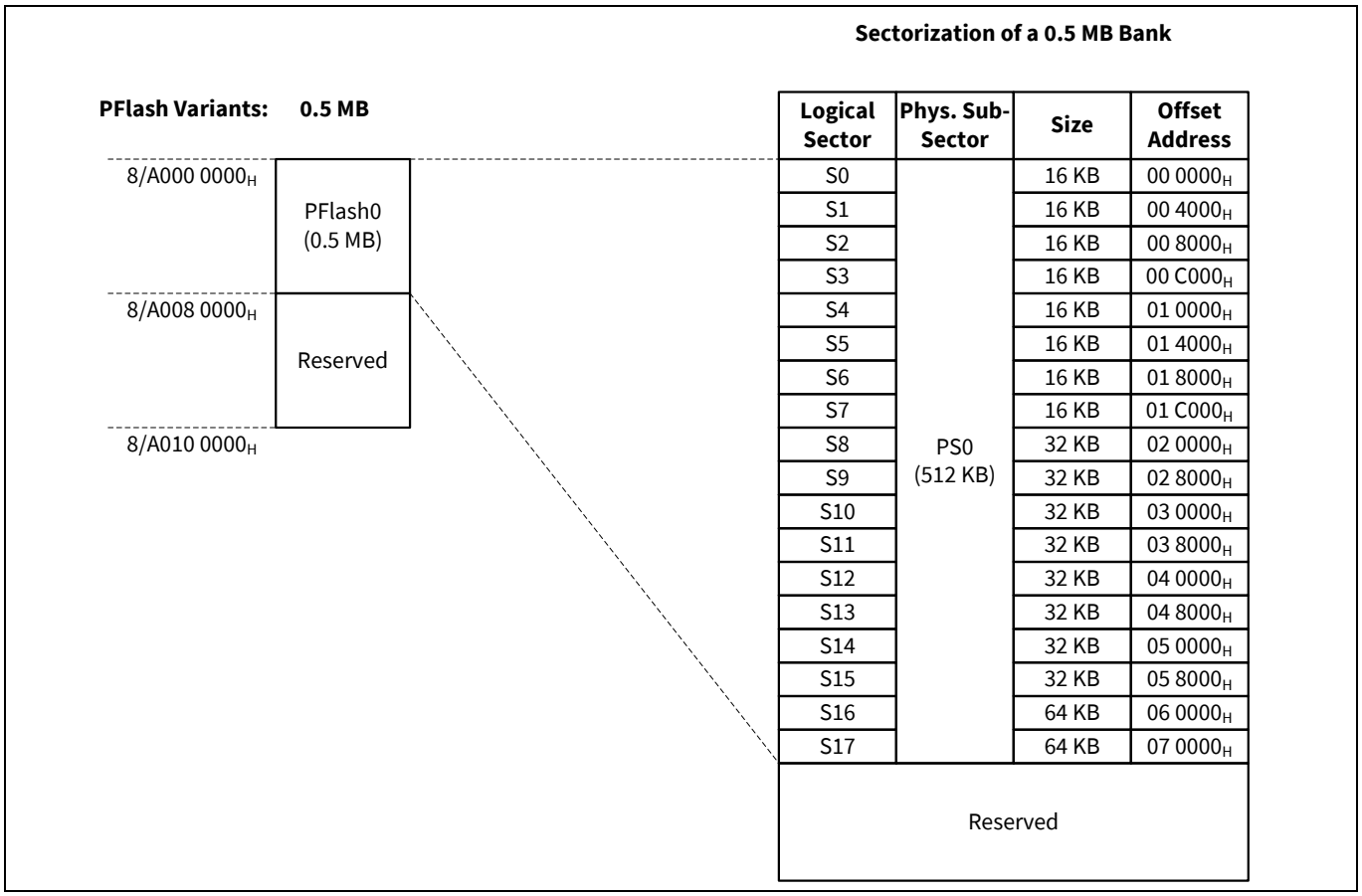


Figure 1 TC21x PFlash variants

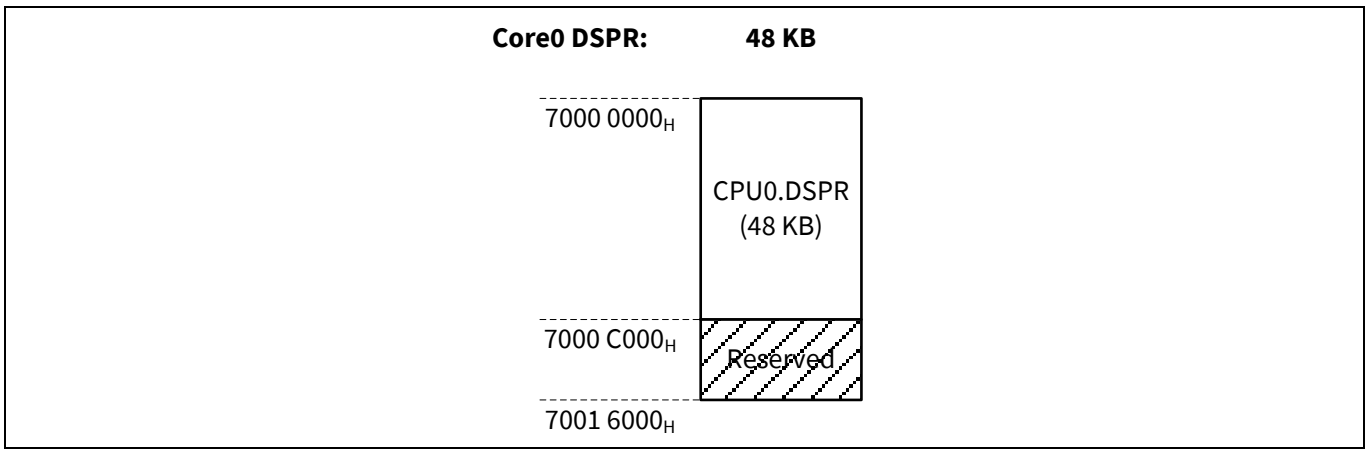


Figure 2 TC21x Coar0 DSPR

Lockstep Variants

No influence on memory ap.

Lockstep = “No” variants: In the Boot Mode Header the BMI.LCL0LSEN must be configured to 0_B.

7.2 TC22X

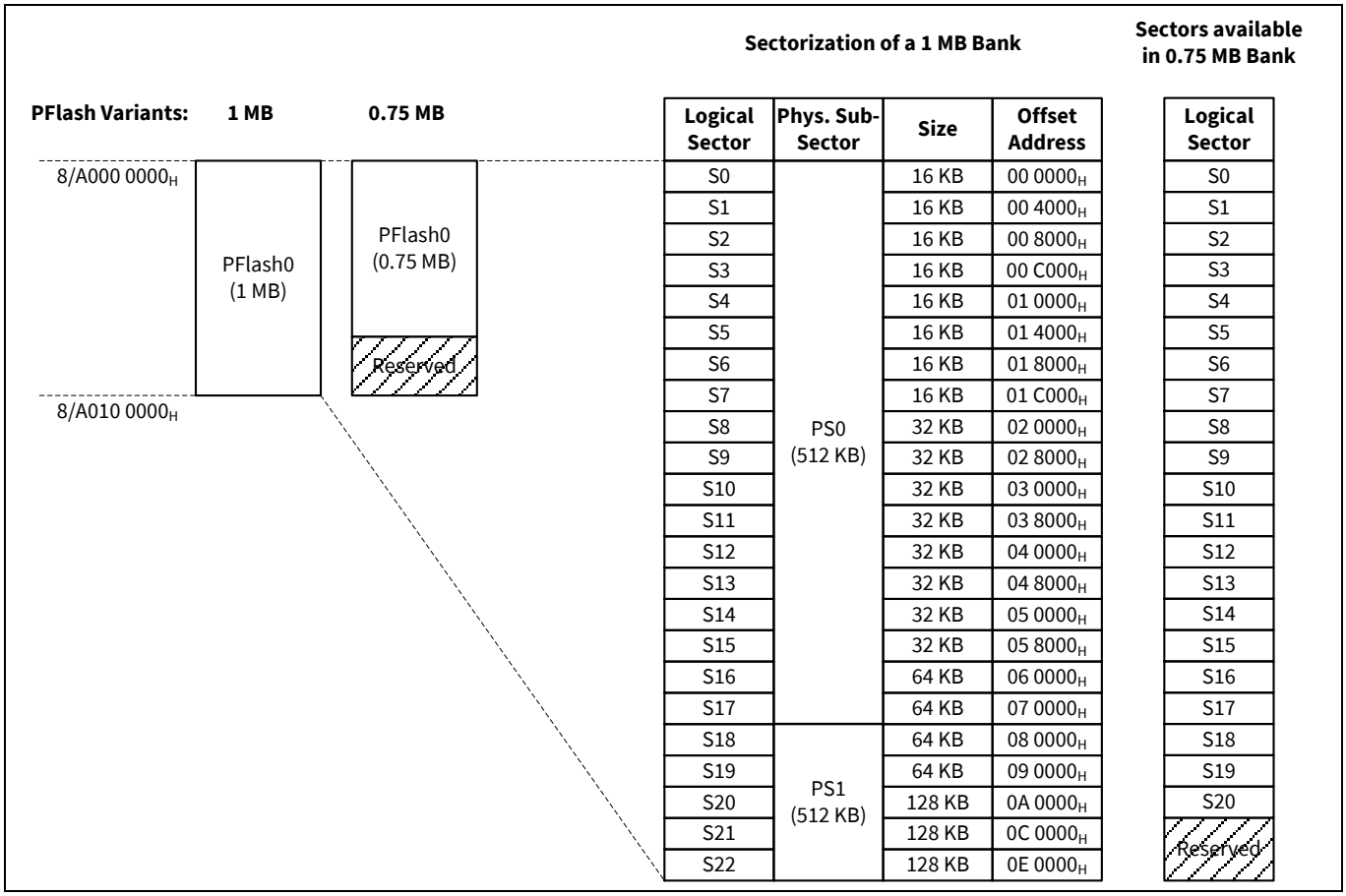


Figure 3 TC22x PFlash variants

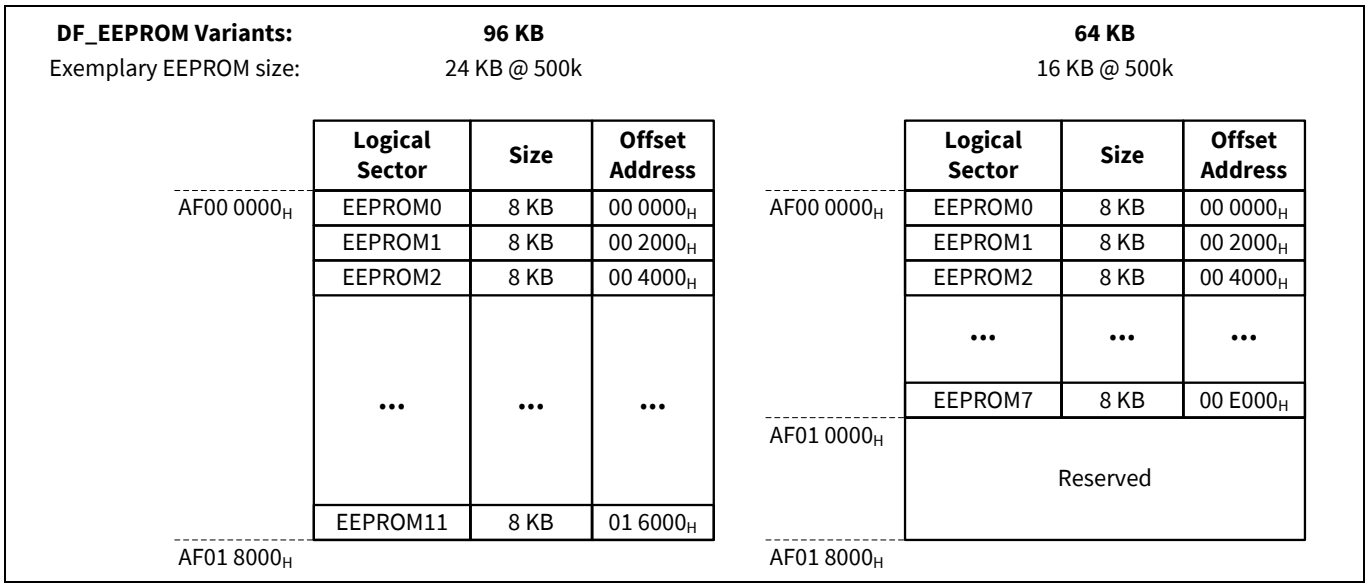


Figure 4 TC22x DF_EEPROM variants

Memory map of variants

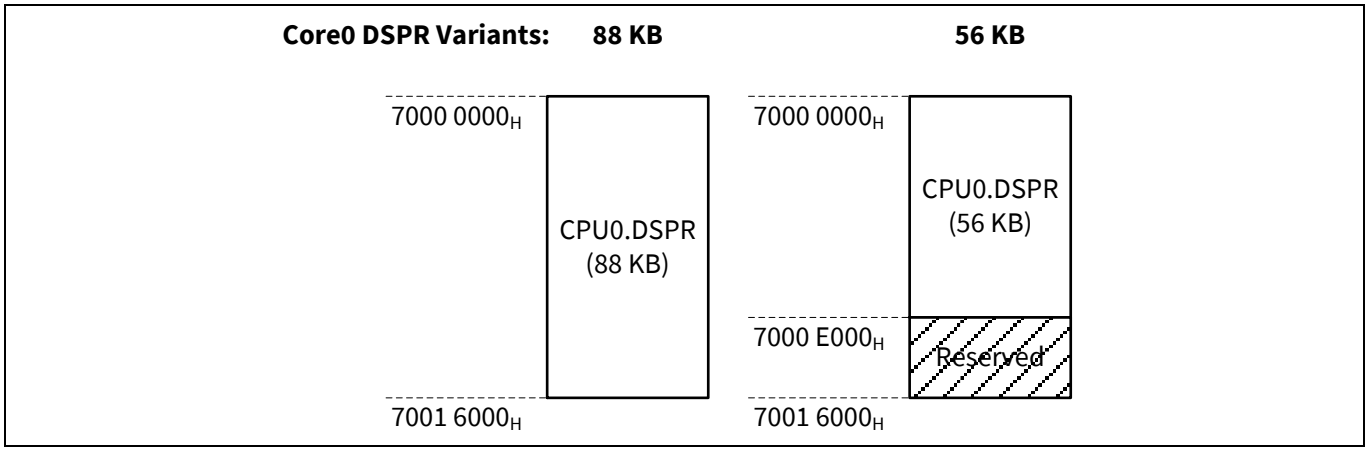
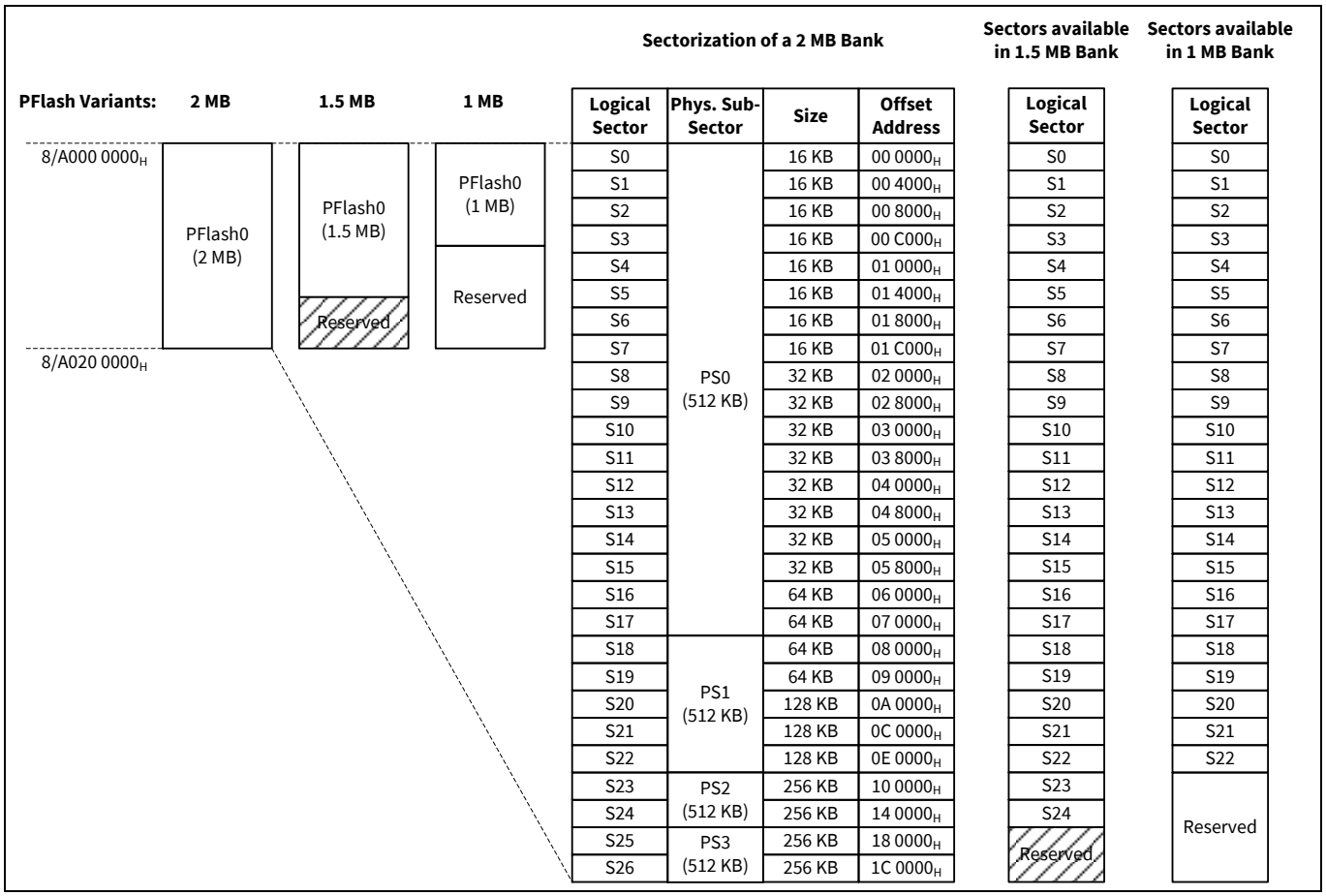


Figure 5 TC22x Core0 DSPR variants

7.3 TC23x



Sectorization of a 2 MB Bank				Sectors available in 1.5 MB Bank	Sectors available in 1 MB Bank
Logical Sector	Phys. Sub-Sector	Size	Offset Address	Logical Sector	Logical Sector
S0	PS0 (512 KB)	16 KB	00 0000H	S0	S0
S1		16 KB	00 4000H	S1	S1
S2		16 KB	00 8000H	S2	S2
S3		16 KB	00 C000H	S3	S3
S4		16 KB	01 0000H	S4	S4
S5		16 KB	01 4000H	S5	S5
S6		16 KB	01 8000H	S6	S6
S7		16 KB	01 C000H	S7	S7
S8		32 KB	02 0000H	S8	S8
S9		32 KB	02 8000H	S9	S9
S10		32 KB	03 0000H	S10	S10
S11		32 KB	03 8000H	S11	S11
S12		32 KB	04 0000H	S12	S12
S13		32 KB	04 8000H	S13	S13
S14		32 KB	05 0000H	S14	S14
S15		32 KB	05 8000H	S15	S15
S16		64 KB	06 0000H	S16	S16
S17		64 KB	07 0000H	S17	S17
S18	PS1 (512 KB)	64 KB	08 0000H	S18	S18
S19		64 KB	09 0000H	S19	S19
S20		128 KB	0A 0000H	S20	S20
S21		128 KB	0C 0000H	S21	S21
S22		128 KB	0E 0000H	S22	S22
S23	PS2 (512 KB)	256 KB	10 0000H	S23	Reserved
S24		256 KB	14 0000H	S24	
S25	PS3 (512 KB)	256 KB	18 0000H	Reserved	
S26		256 KB	1C 0000H		

Figure 6 TC23x PFlash variants

Memory map of variants

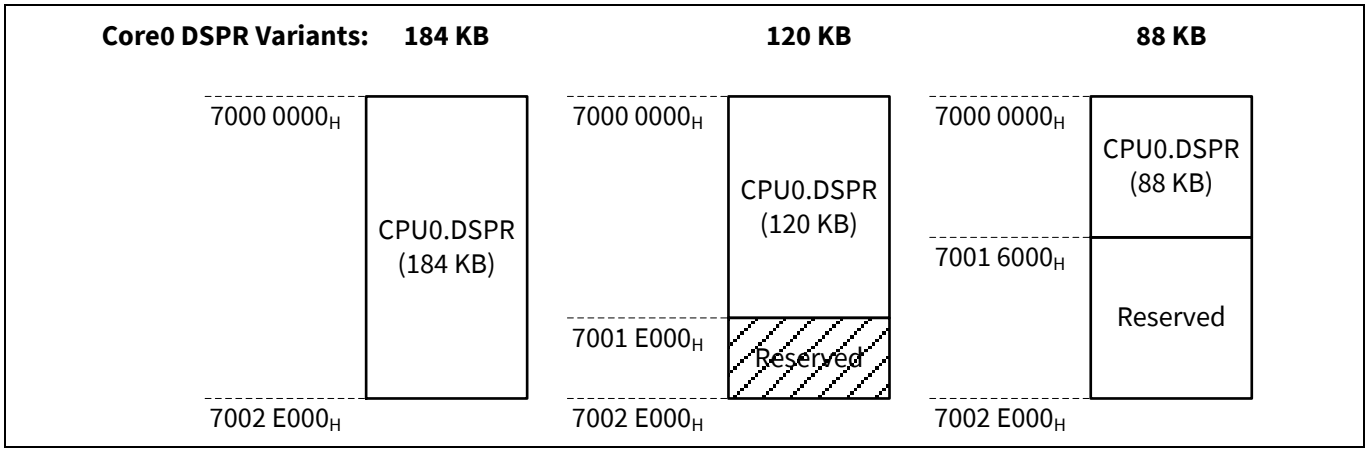


Figure 7 TC23x Core0 DSPR variants

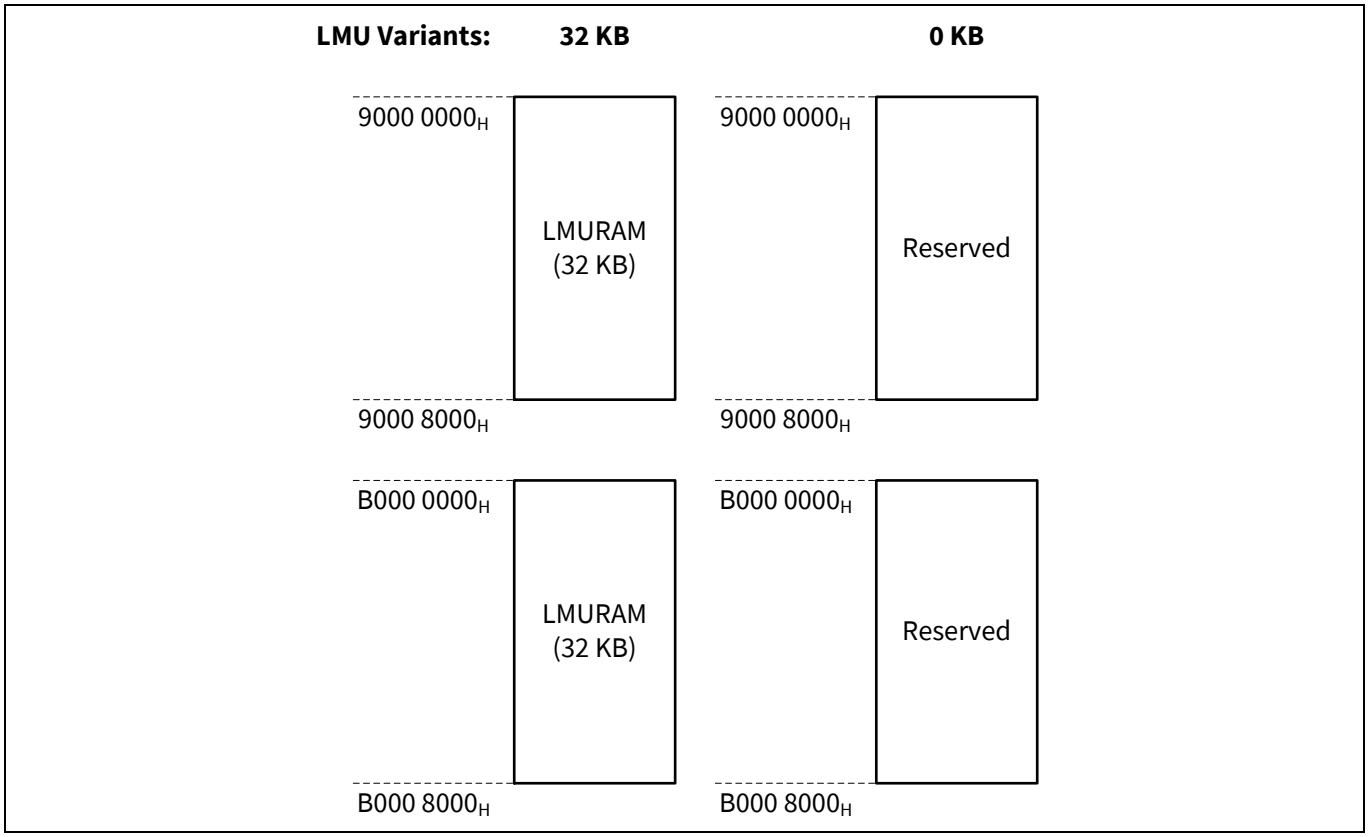


Figure 8 TC23x LMU variants

Memory map of variants

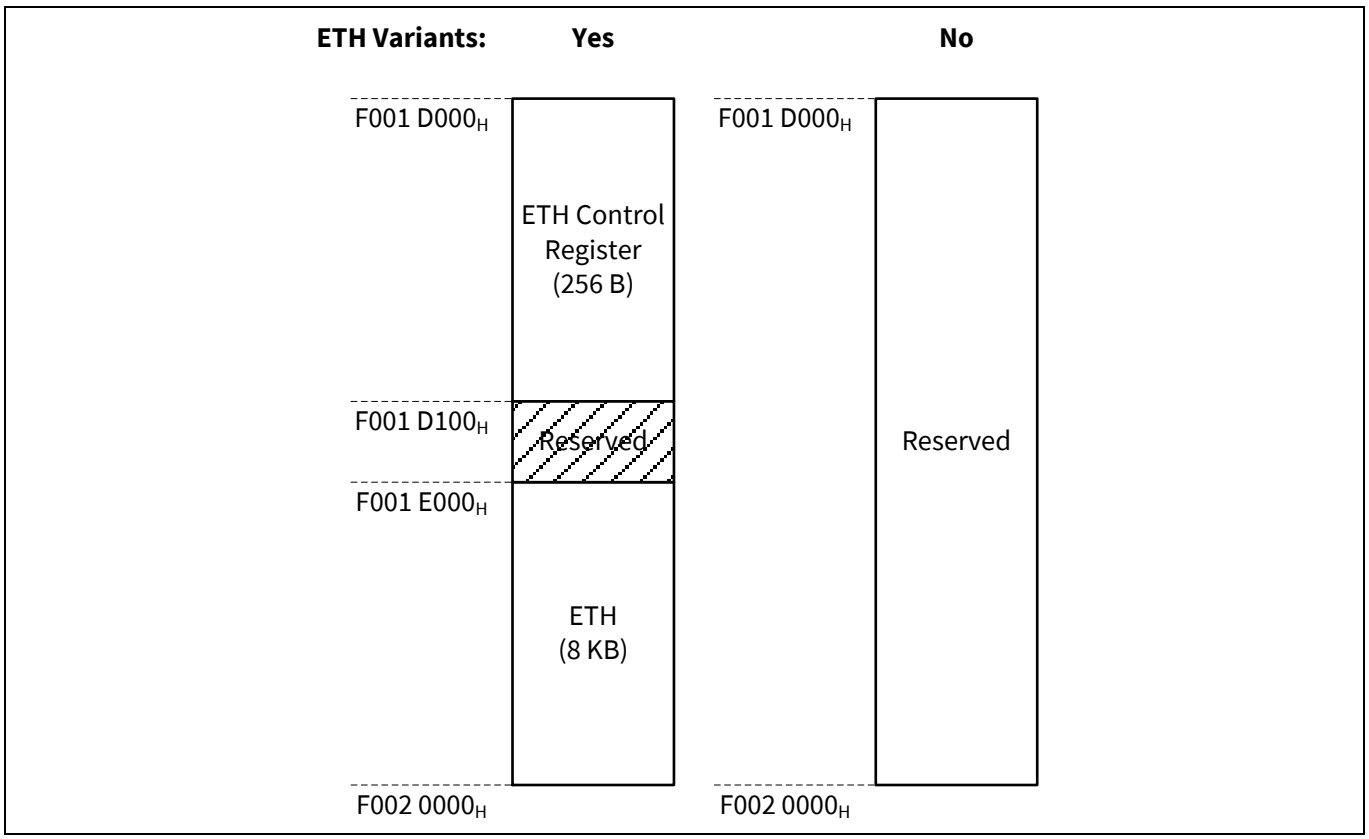


Figure 9 TC23x ETH variants

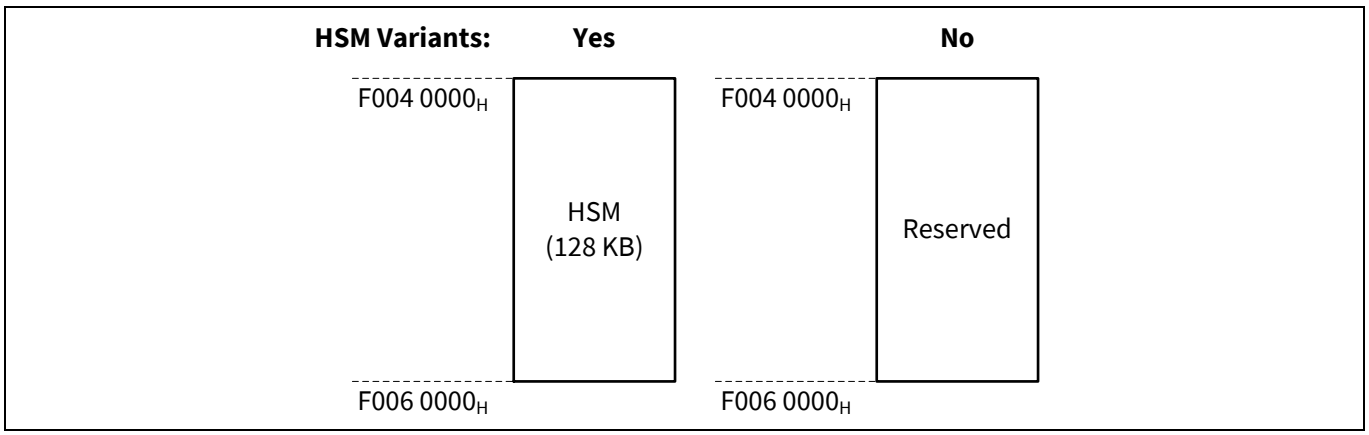


Figure 10 TC23x HSM variants

Memory map of variants

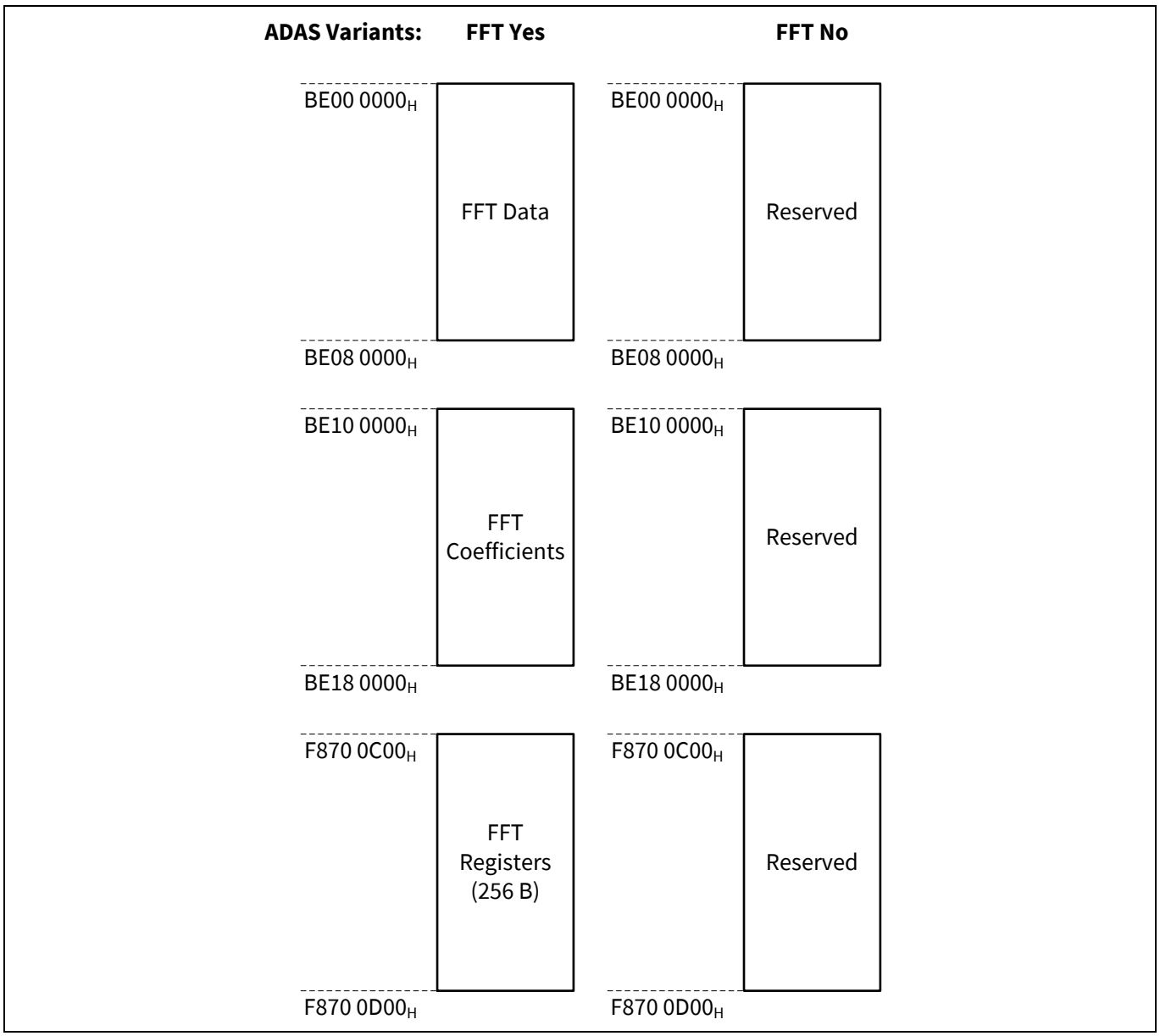


Figure 11 TC23x ADAS variants

ADAS variants

ADAS = “Yes” variants:

The VADC kernels ADC02 and ADC03 are available, offering the Converter Groups G02 and G03. Because of that, the group related registers with x = 2 and x = 3 are implemented.

7.4 TC26x

DF_EEPROM Variants: **96 KB** **72 KB**

Exemplary EEPROM size: 16 KB @ 500k 12 KB @ 500k

	Logical Sector	Size	Offset Address
AF00 0000$_H$	EEPROM0	8 KB	00 0000$_H$
	EEPROM1	8 KB	00 2000$_H$
	EEPROM2	8 KB	00 4000$_H$
	...	...	...
	EEPROM11	8 KB	01 6000$_H$
AF01 8000$_H$			

	Logical Sector	Size	Offset Address
AF00 0000$_H$	EEPROM0	8 KB	00 0000$_H$
	EEPROM1	8 KB	00 2000$_H$
	EEPROM2	8 KB	00 4000$_H$
	...	...	...
	EEPROM8	8 KB	01 0000$_H$
AF01 2000$_H$	Reserved		
AF01 8000$_H$			

Figure 12 TC26x DF_EEPROM variants

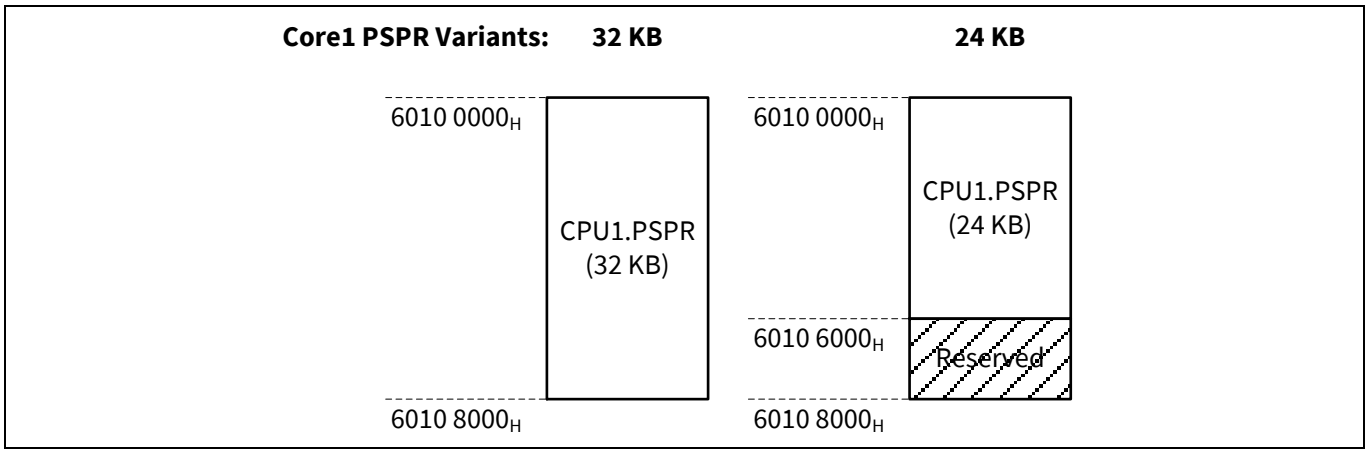


Figure 13 TC26x Core1 PSPR variants

Memory map of variants

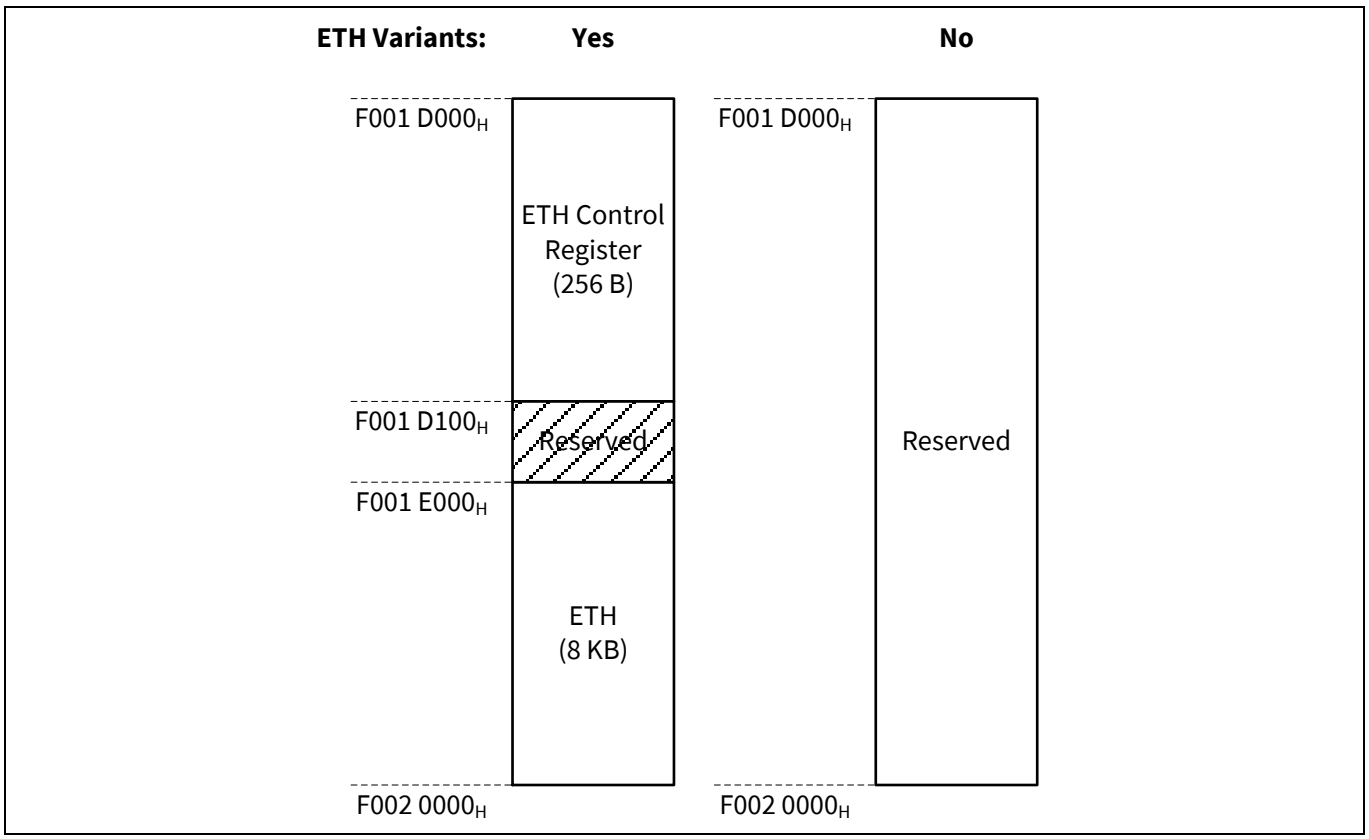


Figure 14 TC26x ETH variants

Memory map of variants

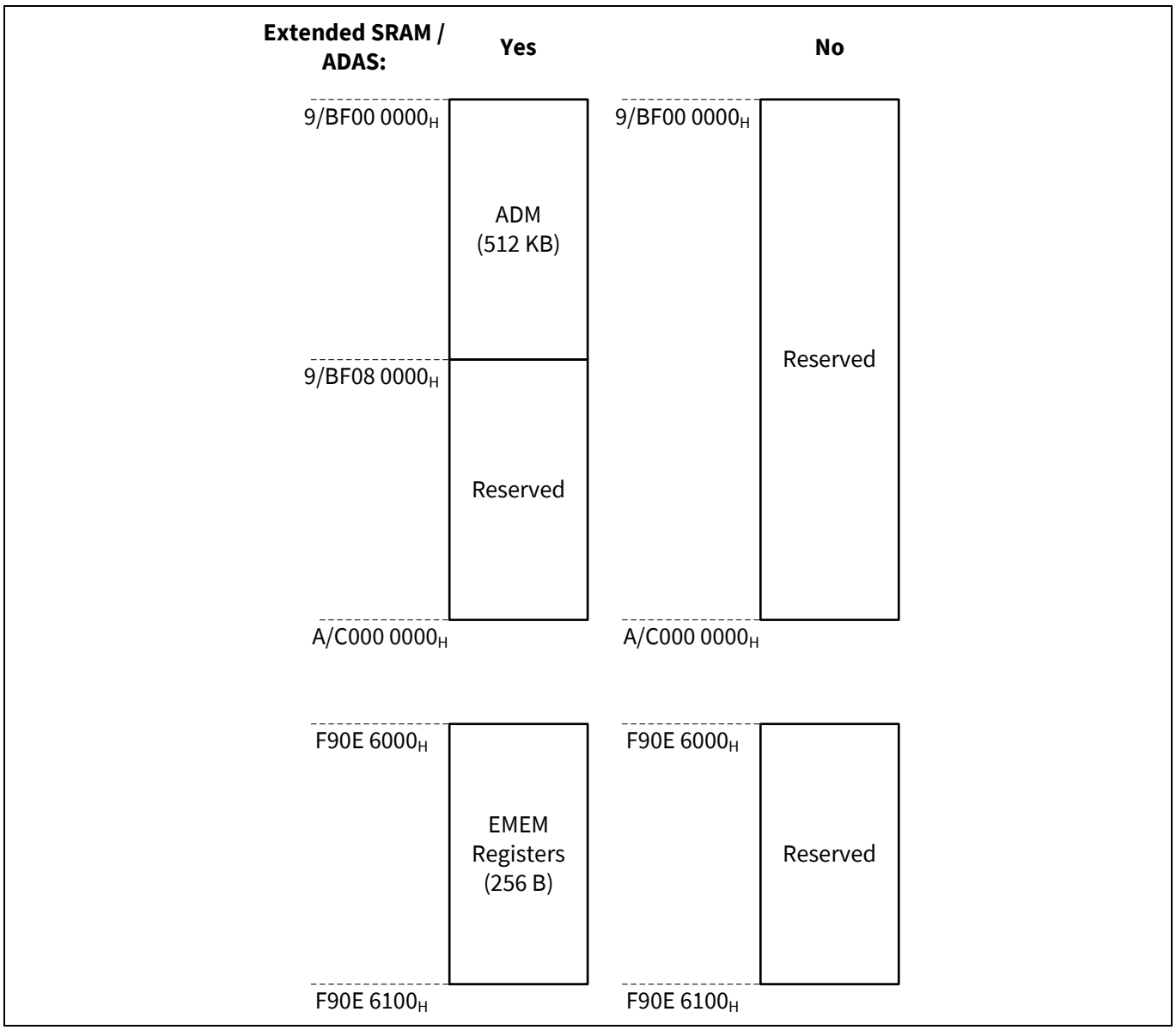


Figure 15 TC26x Extended SRAM / ADAS

Memory map of variants

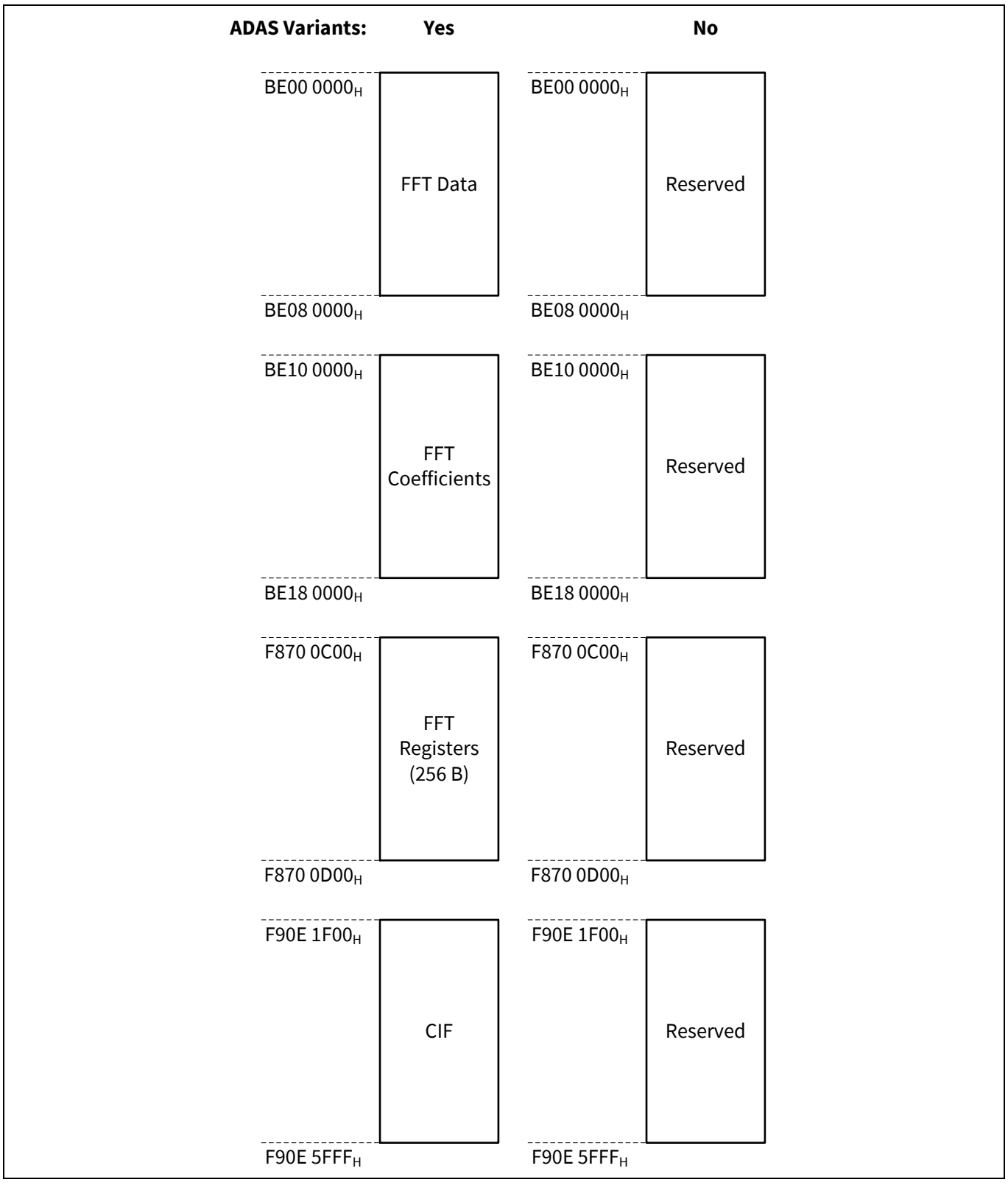


Figure 16 TC26x ADAS variants

CAN FD variants

No influence on Memory Map.

CAN FD = “No” variants: all CAN register fields NCRx.FDEN have to be kept at 0_B.

7.5 TC27x

DF_EEPROM Variants: **384 KB** **144 KB**

Exemplary EEPROM size: 64 KB @ 500k 24 KB @ 500k

	Logical Sector	Size	Offset Address
AF00 0000$_H$	EEPROM0	8 KB	00 0000$_H$
	EEPROM1	8 KB	00 2000$_H$
	EEPROM2	8 KB	00 4000$_H$
	...	...	...
	EEPROM47	8 KB	05 E000$_H$
AF06 0000$_H$			

	Logical Sector	Size	Offset Address
AF00 0000$_H$	EEPROM0	8 KB	00 0000$_H$
	EEPROM1	8 KB	00 2000$_H$
	EEPROM2	8 KB	00 4000$_H$
	...	...	...
	EEPROM17	8 KB	02 2000$_H$
AF02 4000$_H$	Reserved		
AF06 0000$_H$			

Figure 17 TC27x DF_EEPROM variants

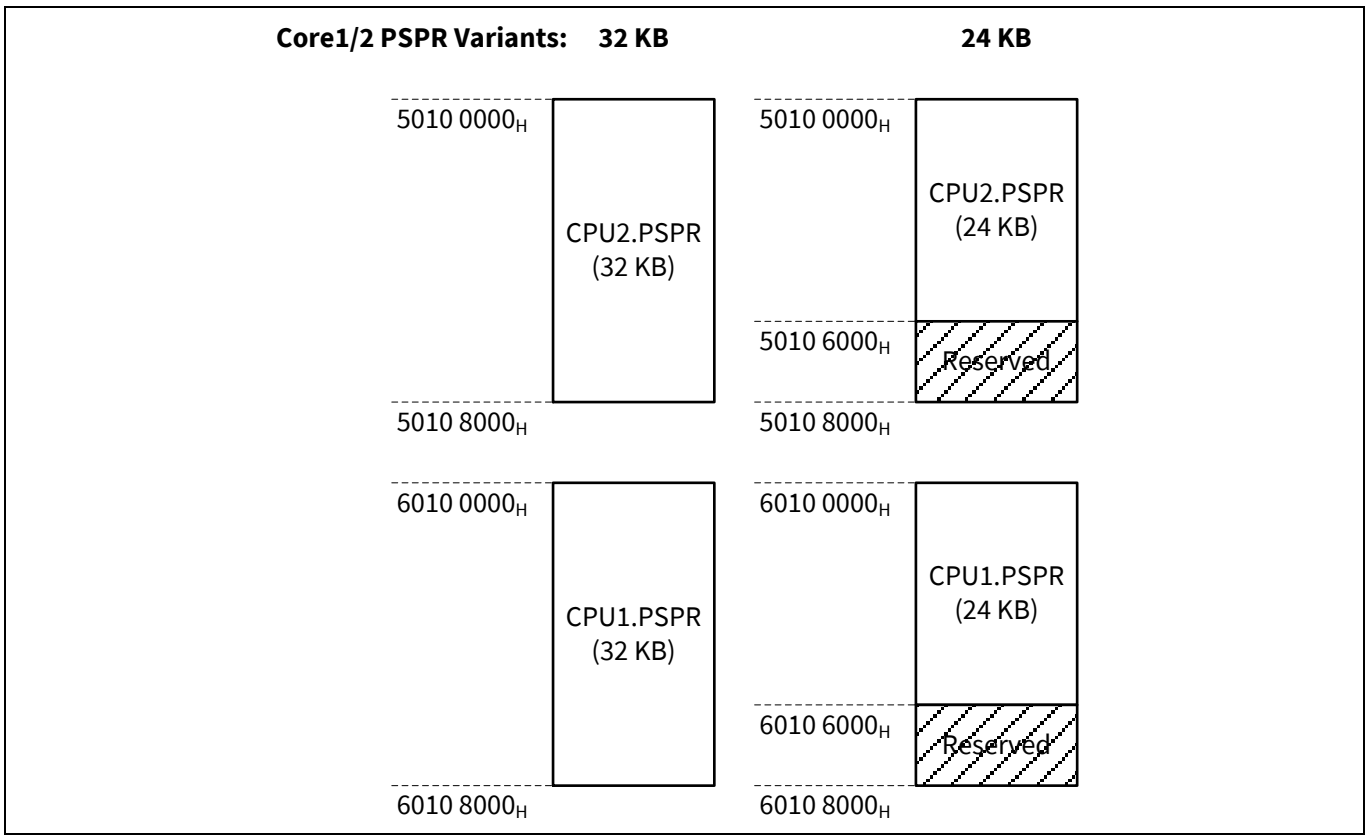


Figure 18 TC27x Core1/2 PSPR variants

Memory map of variants

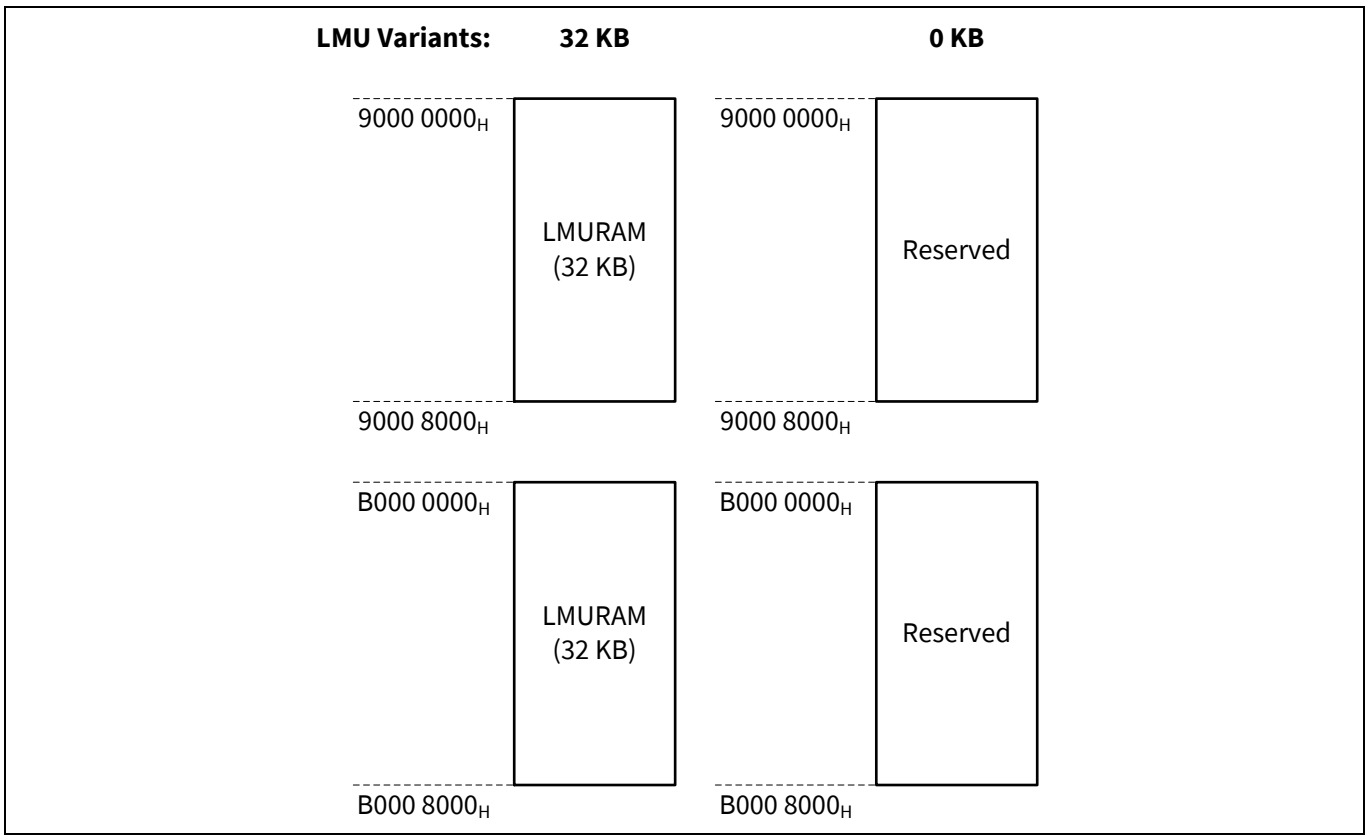


Figure 19 TC27x LMU variants

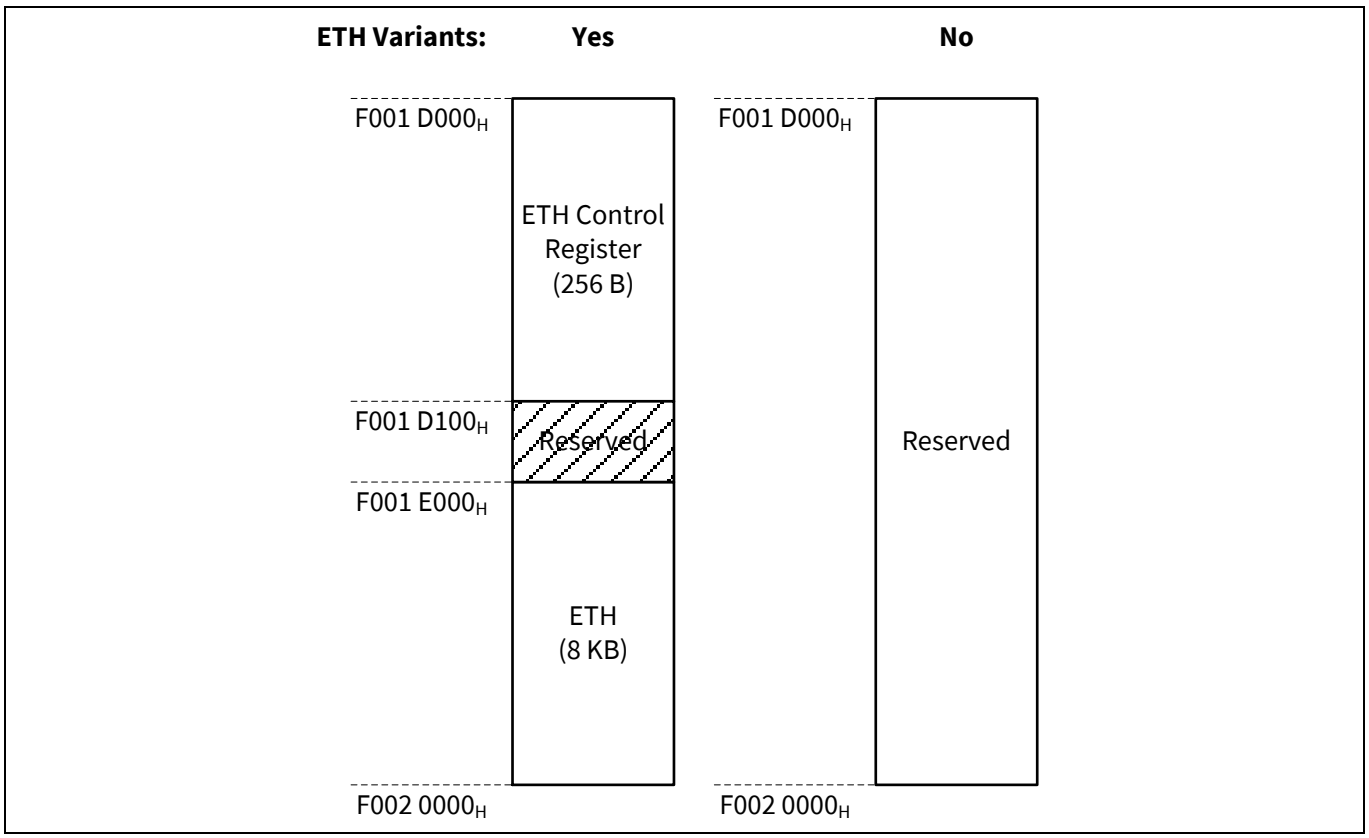


Figure 20 TC27x ETH variants

Memory map of variants

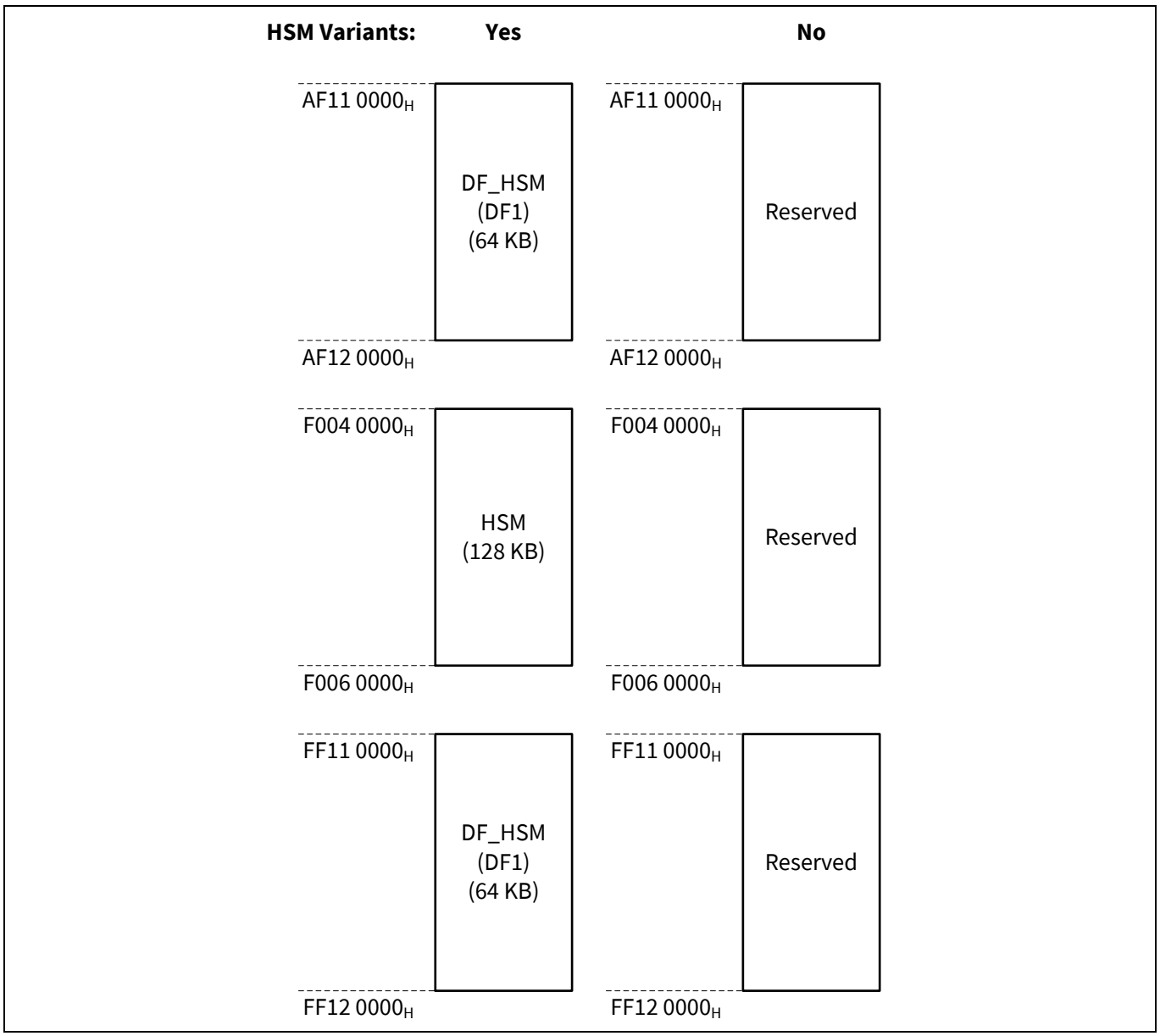


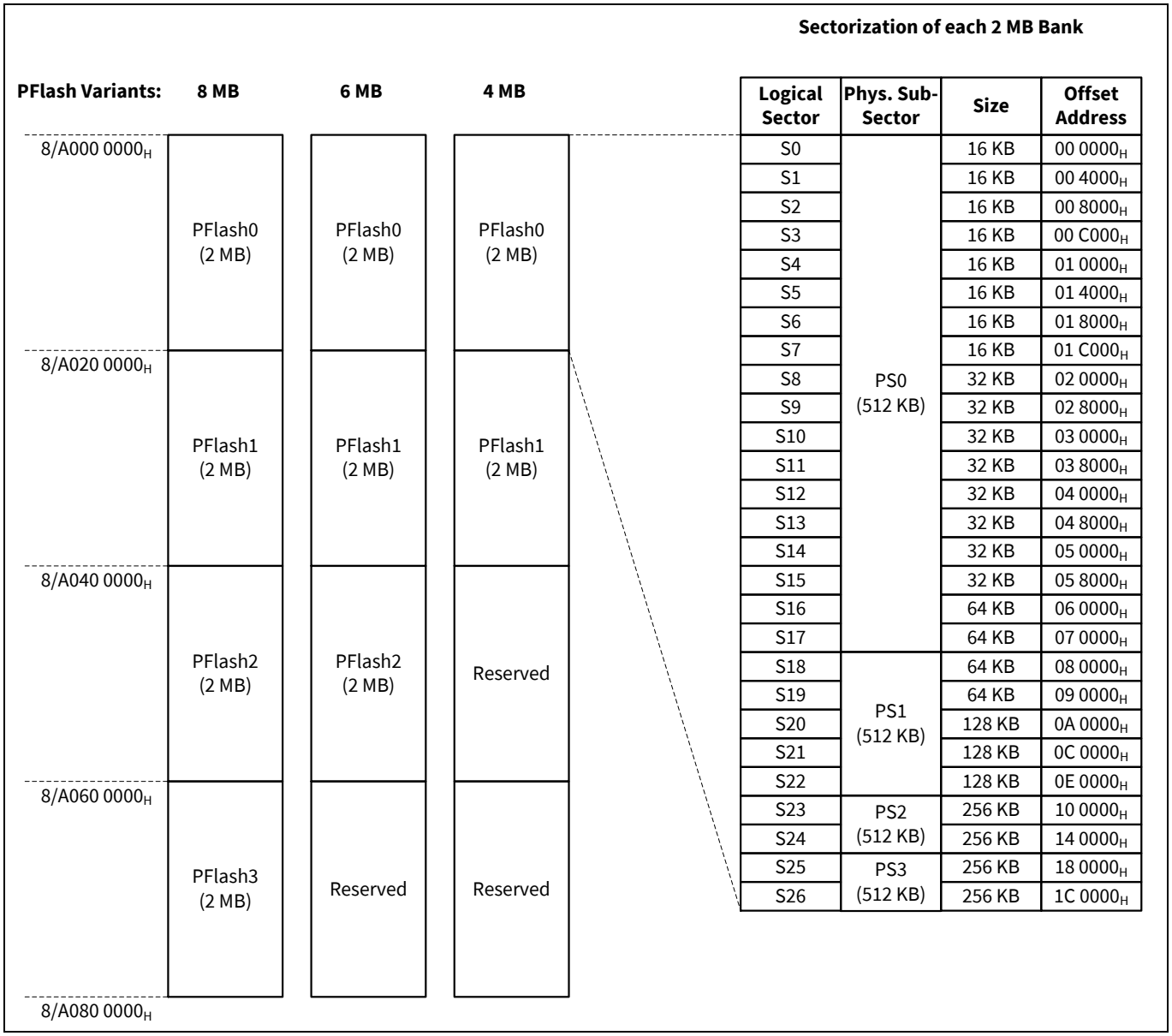
Figure 21 TC27x HSM variants

CAN FD variants

No influence on Memory Map.

CAN FD = “No” variants: all CAN register fields NCRx.FDEN have to be kept at 0_B

7.6 TC29x



Sectorization of each 2 MB Bank

Logical Sector	Phys. Sub-Sector	Size	Offset Address
S0	PS0 (512 KB)	16 KB	00 0000H
S1		16 KB	00 4000H
S2		16 KB	00 8000H
S3		16 KB	00 C000H
S4		16 KB	01 0000H
S5		16 KB	01 4000H
S6		16 KB	01 8000H
S7		16 KB	01 C000H
S8		32 KB	02 0000H
S9		32 KB	02 8000H
S10		32 KB	03 0000H
S11		32 KB	03 8000H
S12		32 KB	04 0000H
S13		32 KB	04 8000H
S14		32 KB	05 0000H
S15		32 KB	05 8000H
S16		64 KB	06 0000H
S17		64 KB	07 0000H
S18	PS1 (512 KB)	64 KB	08 0000H
S19		64 KB	09 0000H
S20		128 KB	0A 0000H
S21		128 KB	0C 0000H
S22		128 KB	0E 0000H
S23	PS2 (512 KB)	256 KB	10 0000H
S24		256 KB	14 0000H
S25	PS3 (512 KB)	256 KB	18 0000H
S26		256 KB	1C 0000H

Figure 22 TC29x PFlash variants

Memory map of variants

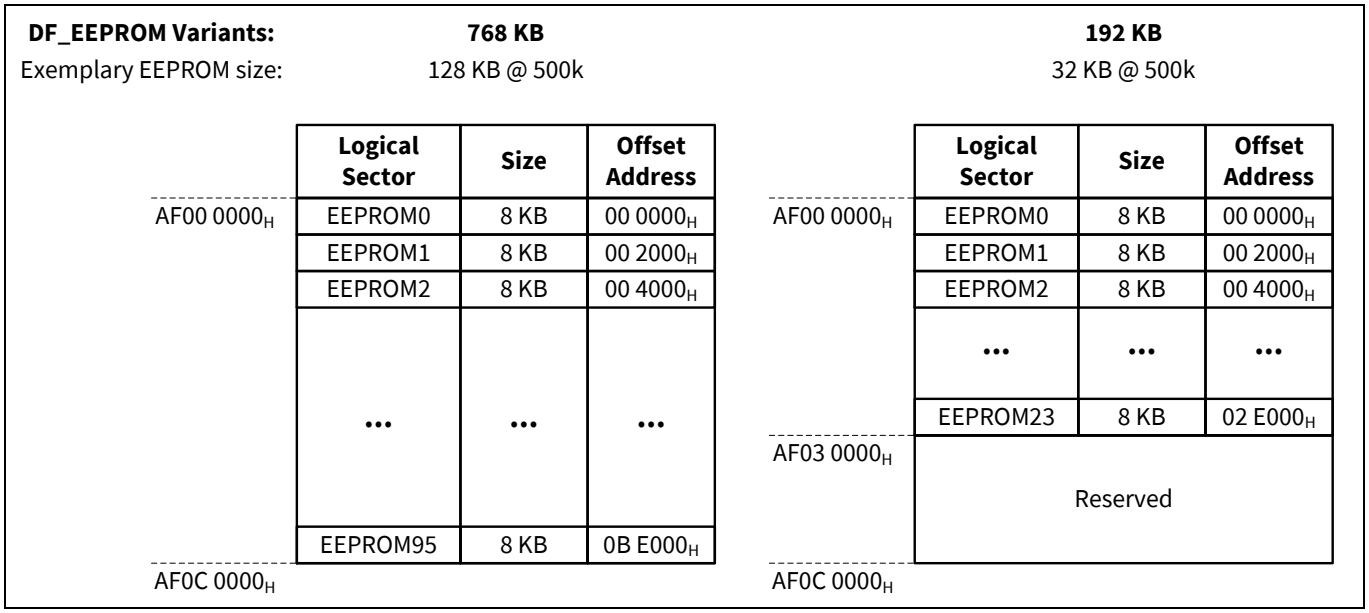


Figure 23 TC29x DF_EEPROM variants

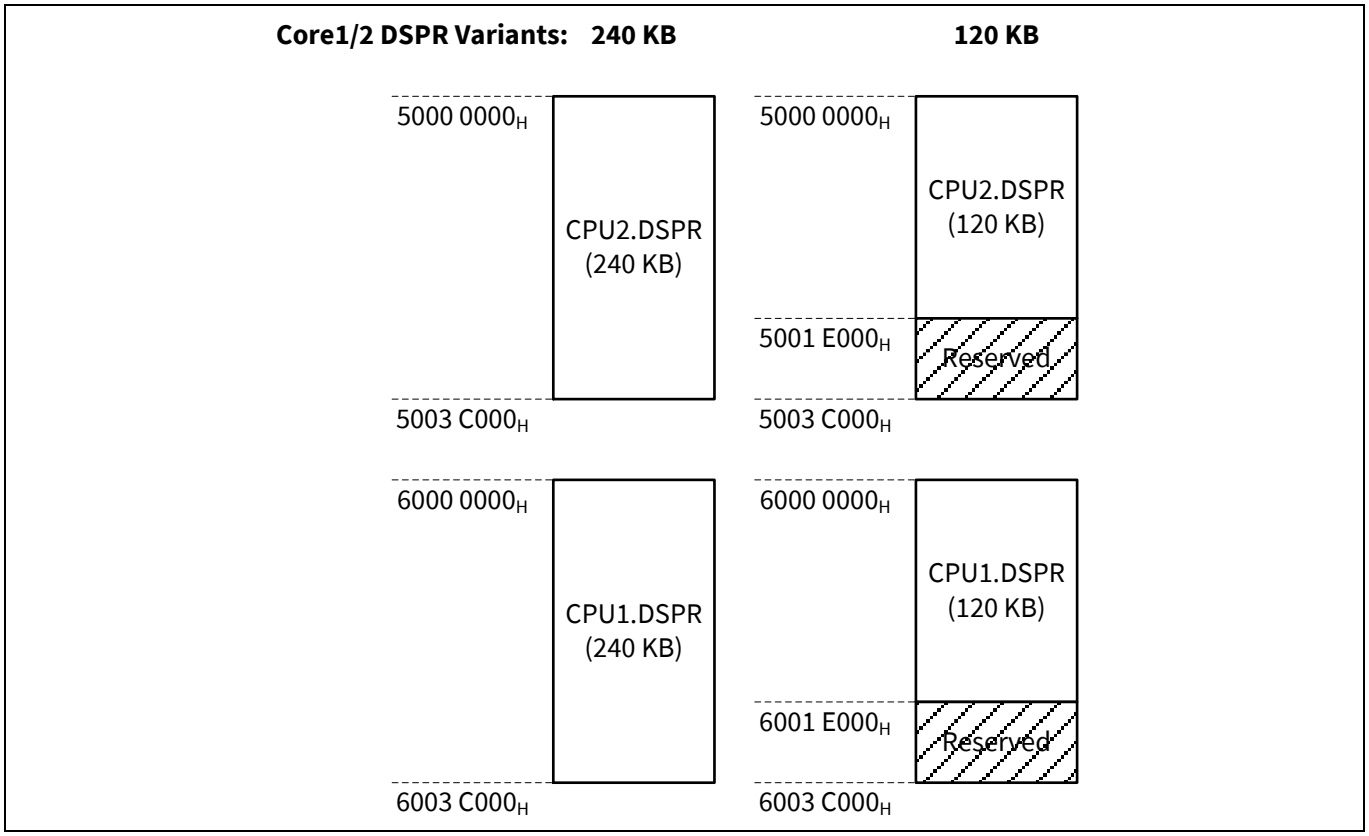


Figure 24 TC29x Core1/2 DSPR variants

Memory map of variants

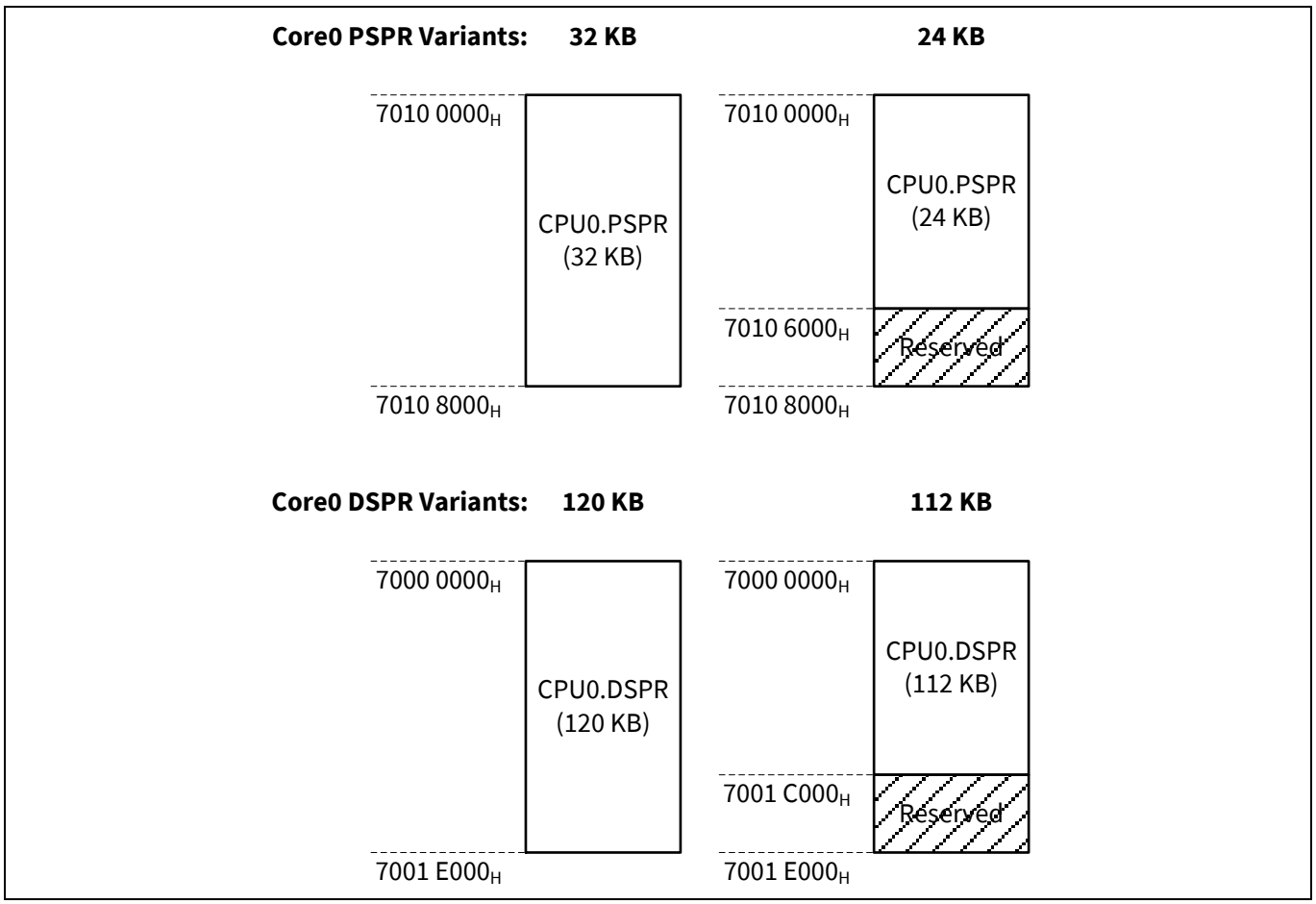


Figure 25 TC29x Core0 PSPR / DSPR variants

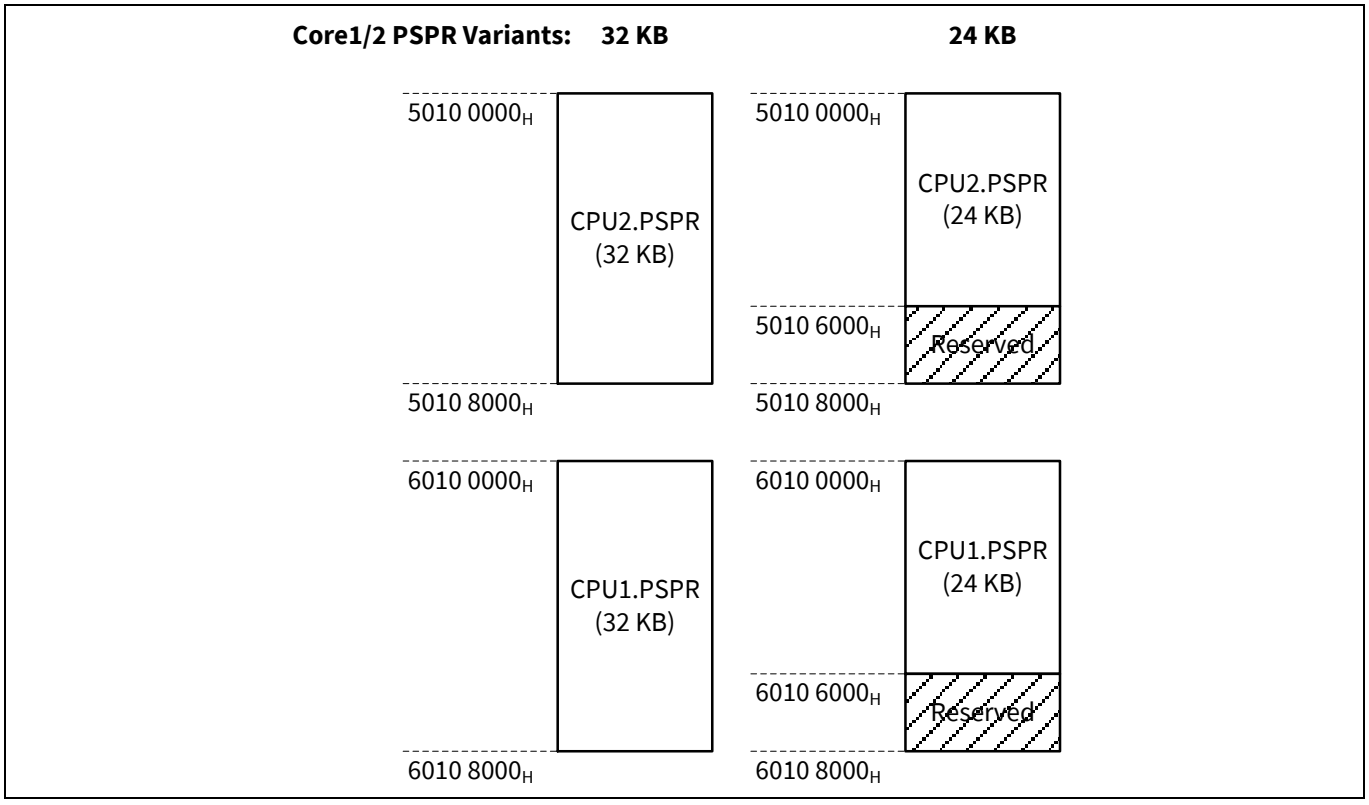


Figure 26 TC29x Core1/2 PSPR variants

Memory map of variants

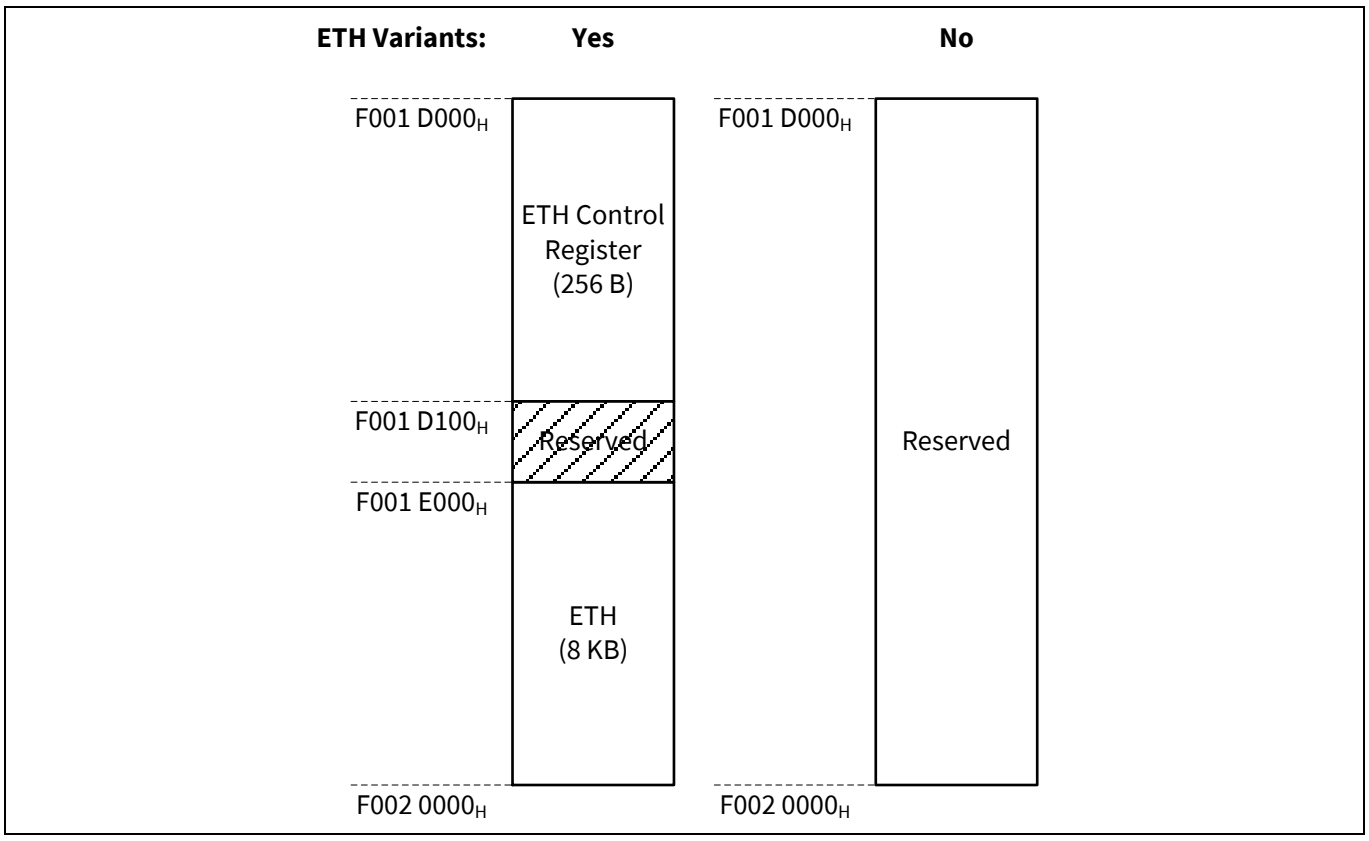


Figure 27 TC29x ETH variants

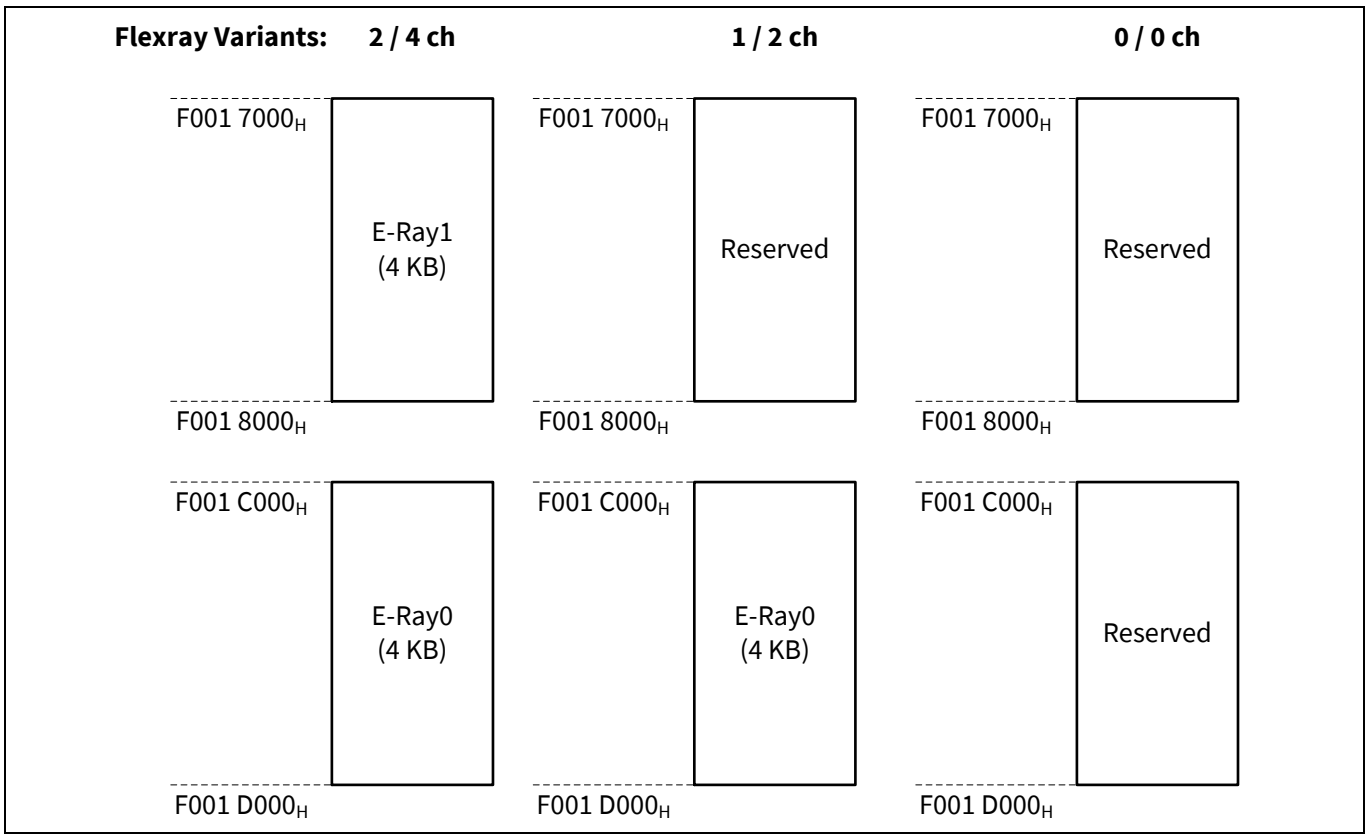


Figure 28 TC29x FlexRay variants

Memory map of variants

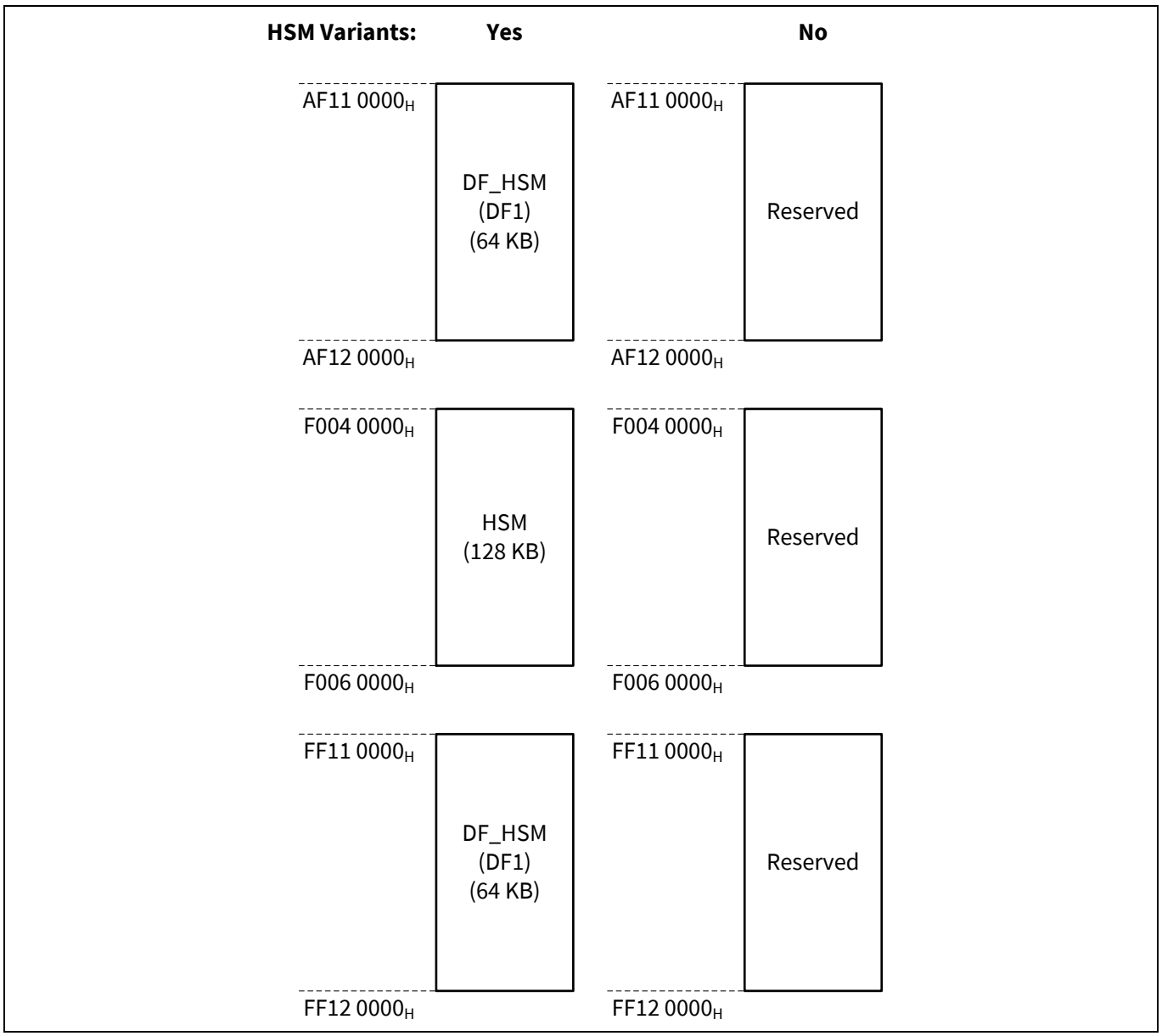


Figure 29 TC29x HSM variants

Memory map of variants

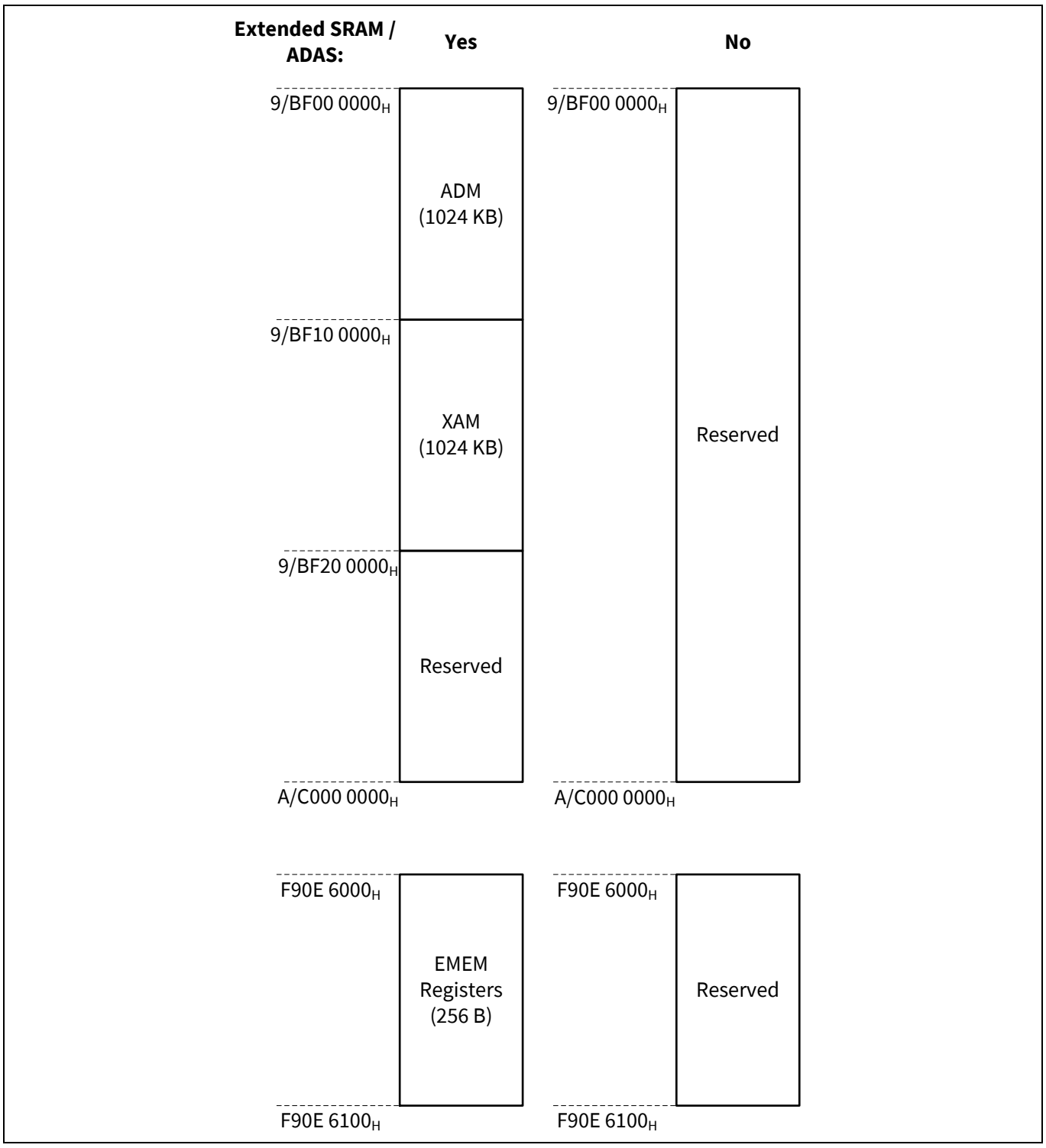


Figure 30 TC29x extended SRAM / ADAS

Memory map of variants

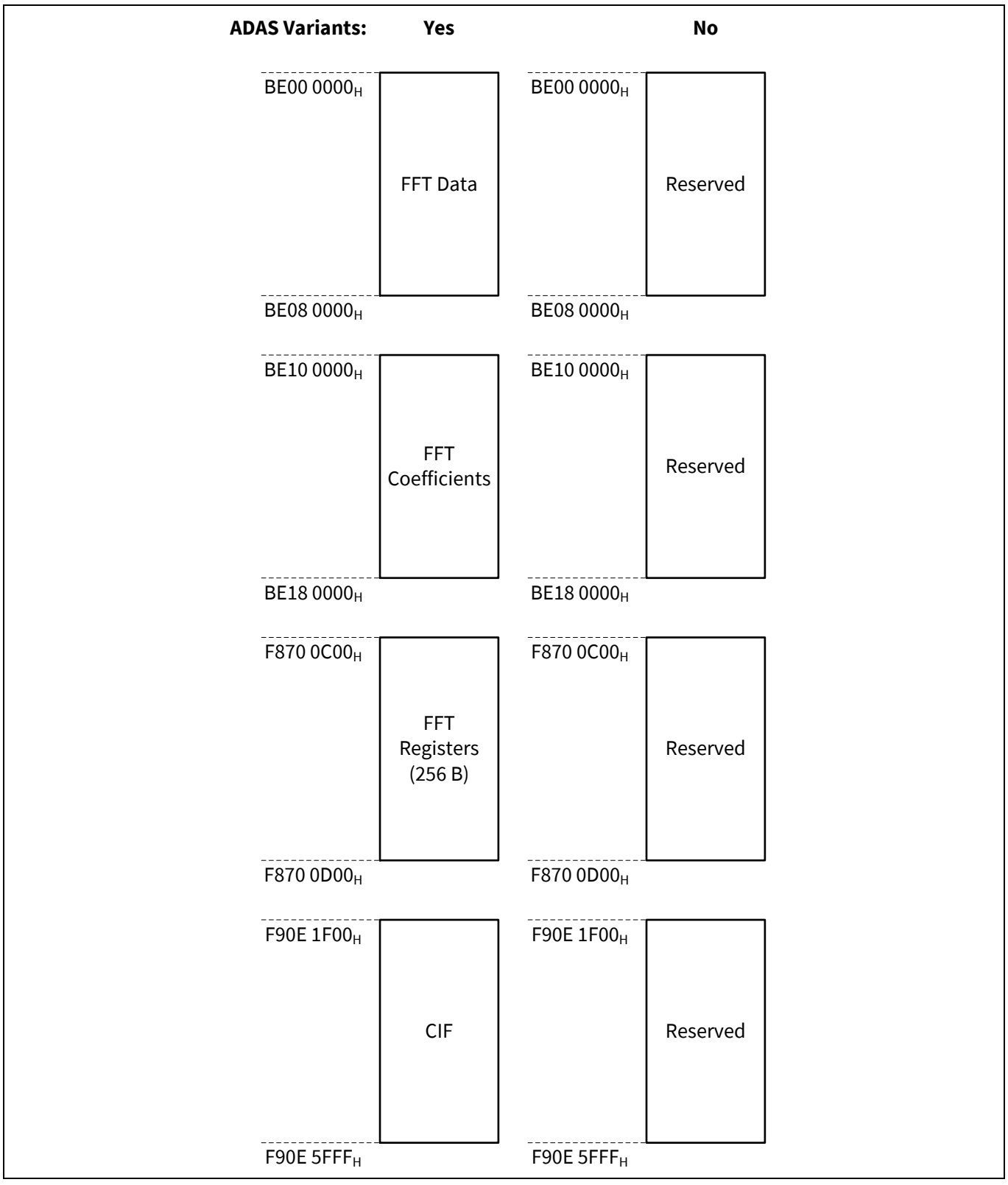


Figure 31 TC29x ADAS variants

CAN FD Variants

No influence on Memory Map.

CAN FD = “No” variants: all CAN register fields NCRx.FDEN have to be kept at 0_B

Revision history

Major changes since the last revision

Page or reference	Description of change
V1.0	First release

Trademarks
All referenced product or service names and trademarks are the property of their respective owners.

Edition 2019-03

Published by

Infineon Technologies AG

81726 Neubiberg, Germany

Do you have a question about this document?

Email: erratum@infineon.com

Document reference ifxDSA0002

IMPORTANT NOTICE

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenheitsgarantie") .

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

For further information on the product, technolog delivery terms and conditions and prices pleas contact your nearest Infineon Technologies offic (**www.infineon.com**).

WARNINGS

Due to technical requirements products may contai dangerous substances. For information on the type in question please contact your nearest Infineo Technologies office.

Except as otherwise explicitly approved by Infineo Technologies in a written document signed b authorized representatives of Infineo Technologies, Infineon Technologies' products ma not be used in any applications where a failure of th product or any consequences of the use thereof ca reasonably be expected to result in personal injury

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Infineon:

TC237L32F200SACKXUMA1 TC234LP32F200FACKXUMA1 TC234L32F200FACKXUMA1
TC233LP32F200NACKXUMA1 TC237LP32F200SACKXUMA1 TC233LP32F200FACKXUMA1
TC237LP32F200NACKXUMA1 TC233L32F200NACKXUMA1 TC234LP32F200NACKXUMA1
TC234L32F200NACKXUMA1 TC299TP128F300NBCLXUMA1 TC297TA128F300NBCKXUMA1
TC299T128F300SBCKXUMA1 TC299TX128F300SBCKXUMA1 TC299TP128F300SBCKXUMA1
TC297TA128F300SBCKXUMA1 TC297TX128F300SBCKXUMA1 TC297TX128F300NBCKXUMA1
TC299TX128F300NBCKXUMA1 TC297TP128F300NBCKXUMA1 TC297TA64F300SBCKXUMA1
TC297TP128F300SBCKXUMA1 TC299TP128F300NBCKXUMA1 TC233LP32F200NACLXUMA1
TC213L8F133NACKXUMA1 TC213L8F133NACLXUMA1 TC237LP32F200NACLXUMA1
TC267D40F200NBCLXUMA1 TC267D40F200NBCKXUMA1 TC297TX128F300SBCKXUMA2
TC299TP128F300SBCKXUMA2 TC297TX128F300NBCKXUMA2 TC299TP128F300NBCLXUMA2
TC265D40F200NBCKXUMA1 TC264D40F200NBCKXUMA2 TC264D40F200NBCLXUMA1
TC212S8F133NACKXUMA1 TC214L8F133NACKXUMA1 TC222L16F133NACKXUMA1 TC222L16F133NACLXUMA1
TC222S16F133NACKXUMA1 TC223L16F133NACKXUMA1 TC224L16F133NACKXUMA1
TC212L8F133NACKXUMA1 TC212L8F133NACLXUMA1 TC264DA40F200WBCKXUMA1
TC233L32F200FACKXUMA1 TC233LP32F200FACLXUMA1 TC237LP32F200SACLXUMA1
TC212L8F133FACKXUMA1 TC213L8F133FACKXUMA1 TC223L16F133FACKXUMA1 TC223L16F133NACLXUMA1
TC223S16F133FACKXUMA1 TC223S16F133FACLXUMA1 TC224L16F133NACLXUMA1
TC237L32F200SACLXUMA1 TC298TP128F300NBCLXUMA2 TC212S8F133FACKXUMA1
TC222L16F133FACKXUMA1 TC222S16F133FACKXUMA1 TC224L16F133FACLXUMA1
TC233L32F200FACLXUMA1 TC264D40F200WBCKXUMA1 TC265D40F200NBCLXUMA1
TC265D40F200WBCKXUMA1 TC267D40F200SBCKXUMA1 TC264DA40F200NBCKXUMA2
TC212S8F133SCACKXUMA1 TC297TA128F300SBCKXUMA2 TC299TP128F300NBCKXUMA2